



P/NO : 3829RDT050N

NOVEMBER, 2006

SERVICE MANUAL

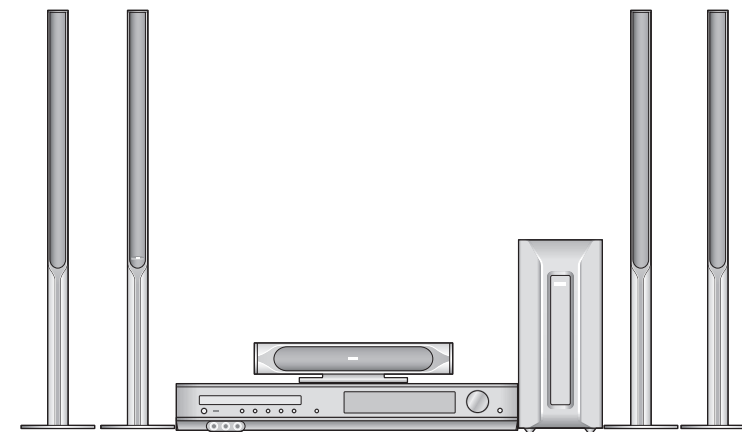
MODEL : LH-T6749(A)/LHS-T6749C/LHS-T6749T/LHS-T6749W

LG



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DVD/CD RECEIVER SERVICE MANUAL



**MODEL : LH-T6749(A)/
LHS-T6749C/LHS-T6749T/LHS-T6749W**

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SECTION 1. GENERAL

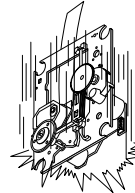
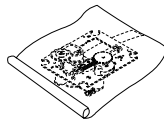
☐ SERVICING PRECAUTIONS

NOTES REGARDING HANDLING OF THE PICK-UP

1. Notes for transport and storage

- 1) The pick-up should always be left in its conductive bag until immediately prior to use.
- 2) The pick-up should never be subjected to external pressure or impact.

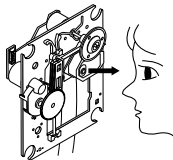
Storage in conductive bag



Drop impact

2. Repair notes

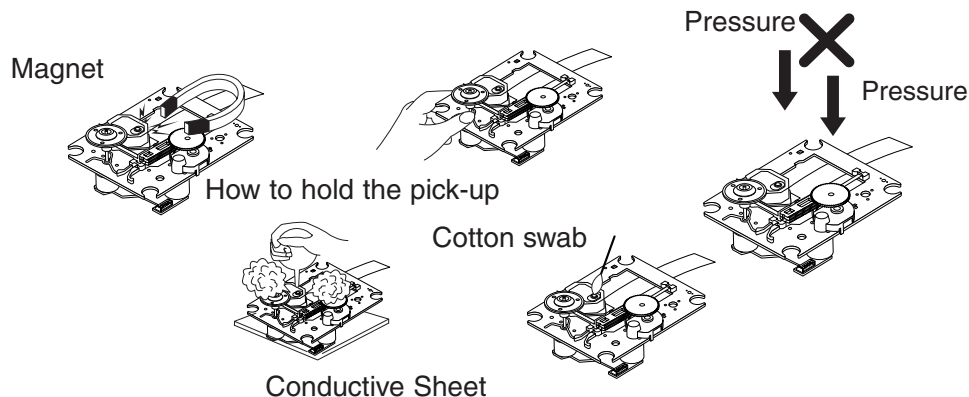
- 1) The pick-up incorporates a strong magnet, and so should never be brought close to magnetic materials.
- 2) The pick-up should always be handled correctly and carefully, taking care to avoid external pressure and impact. If it is subjected to strong pressure or impact, the result may be an operational malfunction and/or damage to the printed-circuit board.
- 3) Each and every pick-up is already individually adjusted to a high degree of precision, and for that reason the adjustment point and installation screws should absolutely never be touched.
- 4) Laser beams may damage the eyes!
Absolutely never permit laser beams to enter the eyes!
Also NEVER switch ON the power to the laser output part (lens, etc.) of the pick-up if it is damaged.



NEVER look directly at the laser beam, and don't let contact fingers or other exposed skin.

5) Cleaning the lens surface

If there is dust on the lens surface, the dust should be cleaned away by using an air bush (such as used for camera lens). The lens is held by a delicate spring. When cleaning the lens surface, therefore, a cotton swab should be used, taking care not to distort this.



6) Never attempt to disassemble the pick-up.

Spring by excess pressure. If the lens is extremely dirty, apply isopropyl alcohol to the cotton swab. (Do not use any other liquid cleaners, because they will damage the lens.) Take care not to use too much of this alcohol on the swab, and do not allow the alcohol to get inside the pick-up.

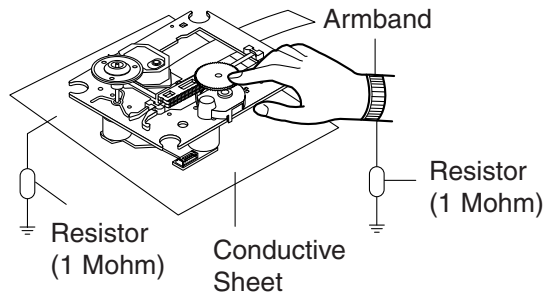
NOTES REGARDING COMPACT DISC PLAYER REPAIRS

1. Preparations

- 1) Compact disc players incorporate a great many ICs as well as the pick-up (laser diode). These components are sensitive to, and easily affected by, static electricity. If such static electricity is high voltage, components can be damaged, and for that reason components should be handled with care.
- 2) The pick-up is composed of many optical components and other high-precision components. Care must be taken, therefore, to avoid repair or storage where the temperature or humidity is high, where strong magnetism is present, or where there is excessive dust.

2. Notes for repair

- 1) Before replacing a component part, first disconnect the power supply lead wire from the unit
- 2) All equipment, measuring instruments and tools must be grounded.
- 3) The workbench should be covered with a conductive sheet and grounded.
When removing the laser pick-up from its conductive bag, do not place the pick-up on the bag. (This is because there is the possibility of damage by static electricity.)
- 4) To prevent AC leakage, the metal part of the soldering iron should be grounded.
- 5) Workers should be grounded by an armband (1M Ω)
- 6) Care should be taken not to permit the laser pick-up to come in contact with clothing, in order to prevent static electricity changes in the clothing to escape from the armband.
- 7) The laser beam from the pick-up should NEVER be directly facing the eyes or bare skin.



❑ ESD PRECAUTIONS

Electrostatically Sensitive Devices (ESD)



Some semiconductor (solid state) devices can be damaged easily by static electricity. Such components commonly are called Electrostatically Sensitive Devices (ESD). Examples of typical ESD devices are integrated circuits and some field-effect transistors and semiconductor chip components. The following techniques should be used to help reduce the incidence of component damage caused by static electricity.

1. Immediately before handling any semiconductor component or semiconductor-equipped assembly, drain off any electrostatic charge on your body by touching a known earth ground. Alternatively, obtain and wear a commercially available discharging wrist strap device, which should be removed for potential shock reasons prior to applying power to the unit under test.
2. After removing an electrical assembly equipped with ESD devices, place the assembly on a conductive surface such as aluminum foil, to prevent electrostatic charge buildup or exposure of the assembly.
3. Use only a grounded-tip soldering iron to solder or unsolder ESD devices.
4. Use only an anti-static solder removal device. Some solder removal devices not classified as "anti-static" can generate electrical charges sufficient to damage ESD devices.
5. Do not use freon-propelled chemicals. These can generate electrical charges sufficient to damage ESD devices.
6. Do not remove a replacement ESD device from its protective package until immediately before you are ready to install it. (Most replacement ESD devices are packaged with leads electrically shorted together by conductive foam, aluminum foil or comparable conductive materials).
7. Immediately before removing the protective material from the leads of a replacement ESD device, touch the protective material to the chassis or circuit assembly into which the device will be installed.

CAUTION : BE SURE NO POWER IS APPLIED TO THE CHASSIS OR CIRCUIT, AND OBSERVE ALL OTHER SAFETY PRECAUTIONS.

8. Minimize bodily motions when handling unpackaged replacement ESD devices. (Otherwise harmless motion such as the brushing together of your clothes fabric or the lifting of your foot from a carpeted floor can generate static electricity sufficient to damage an ESD device).

CAUTION. GRAPHIC SYMBOLS

	THE LIGHTNING FLASH WITH APROWHEAD SYMBOL. WITHIN AN EQUILATERAL TRIANGLE, IS INTENDED TO ALERT THE SERVICE PERSONNEL TO THE PRESENCE OF UNINSULATED "DANGEROUS VOLTAGE" THAT MAY BE OF SUFFICIENT MAGNITUDE TO CONSTITUTE A RISK OF ELECTRIC SHOCK.
	THE EXCLAMATION POINT WITHIN AN EQUILATERAL TRIANGLE IS INTENDED TO ALERT THE SERVICE PERSONNEL TO THE PRESENCE OF IMPORTANT SAFETY INFORMATION IN SERVICE LITERATURE.

SPECIFICATIONS

[General]		Power supply	Refer to main label		
		Power consumption	Refer to main label		
		Mass	4. 4kg		
		External dimensions (W x H x D)	430 x 60 x 350mm		
		Operating conditions	Temperature: 5°C to 35°C, Operation status: Horizontal		
		Operating humidity	5% to 85%		
[CD/DVD]		Laser	Semiconductor laser, wavelength 650 nm		
		Signal system	PAL 625/50, NTSC 525/60		
		Frequency response (audio)	150 Hz to 18 kHz		
		Signal-to-noise ratio (audio)	More than 75 dB (1 kHz, NOP -6dB, 20 kHz LPF/A-Filter)		
		Dynamic range (audio)	More than 70 dB		
		Harmonic distortion (audio)	1% (1 kHz, at 1W position) (20 kHz LPF)		
[Video]		Video input	1.0 V (p-p), 75Ω , negative sync., RCA jack x 2/SCART(To TV)		
		Video output	1.0 V (p-p), 75Ω , negative sync., RCA jack x 1/SCART(To TV)		
		S-video output	(Y) 1.0 V (p-p), 75Ω , negative sync., Mini DIN 4-pin x 1 (C) 0.3 V (p-p), 75Ω		
[Tuner]	[FM]	Tuning Range	87.5 - 108.0 MHz or 65.0 -74.0 MHz, 87.5 -108.0MHz		
		Intermediate Frequency	10.7 MHz		
		Signal-to Noise Ratio	60dB (Mono)		
	AM [MW]	Frequency Response	150 - 8,000 Hz		
		Tuning Range	522~1,611kHz, 530 ~1,610kHz		
		Intermediate Frequency	450 kHz		
[Amplifier]		Stereo mode	90W +90W (6Ω at 1 kHz, THD 10 %)		
		Surround mode (* Depending on the sound mode settings and the source, there may be no sound output.)	Front: 90W + 90W (THD 10 %) Centre*: 90W Surround*: 90W + 90W (6Ω at 1 kHz, THD 10 %) Subwoofer*: 150W (4Ω at 30 Hz, THD 10 %)		
		Inputs	VIDEO 1, VIDEO 2, COAXIAL AUDIO, OPTICAL AUDIO		
		Outputs	S-VIDEO, MONITOR, PHONES: 32Ω ,(1.0 V),COMPONENT		
[Speakers]			Surround Speaker (LHS-T6749T)	Centre speaker (LHS-T6749C)	Passive Subwoofer (LHS-T6749W)
		Type	2 Way 2 Speaker	2 Way 2 Speaker	1Way 1Speaker
		Impedance	6Ω	6Ω	4Ω
		Frequency Response	150-20,000 Hz	150 -20,000 Hz	40 - 200 Hz
		Sound Pressure Level	84 dB/W (1m)	84 dB/W (1m)	83 dB/W (1m)
		Rated Input Power	90W	90 W	150 W
		Max. Input Power	180 W	180W	300 W
		Net Dimensions (W x H x D)	70x1200x 72mm	440x 88 x 77mm	195x 398 x 417 mm
		Net Weight	3.2kg	1.8kg	7.6kg
[Supplied Accessories]		• Speakers6			
		• Speaker cables6			
		• AM loop antenna1			
		• FM antenna1			
		• Remote control1			
		• Batteries (AAA)2			

Designs and specifications are subject to change without notice.

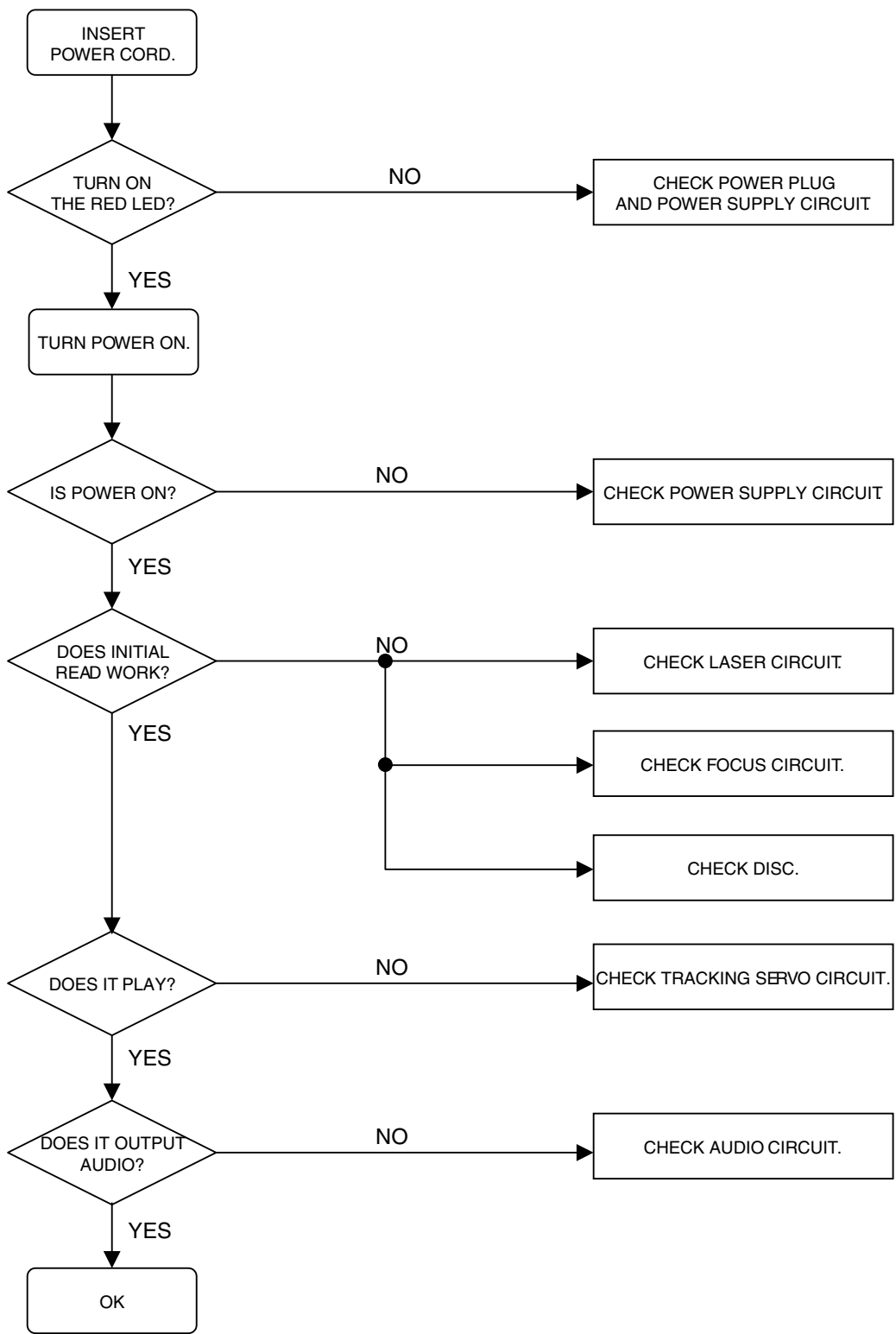
MEMO

This image shows a single sheet of white paper with horizontal ruling lines. The lines are evenly spaced and run across the width of the page. There are no margins, text, or other markings on the paper.

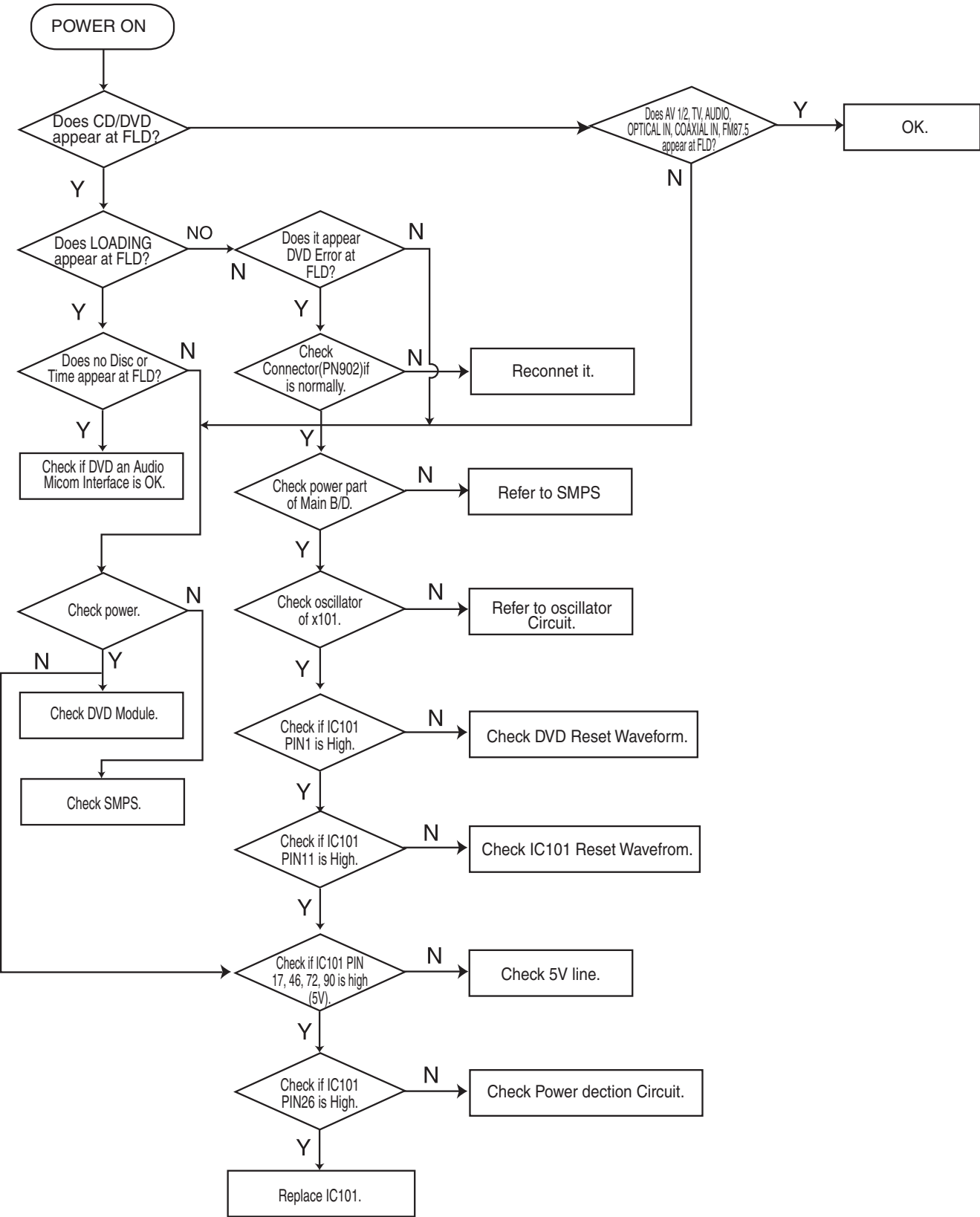
SECTION 2. AUDIO PART

□ ELECTRICAL TROUBLESHOOTING GUIDE

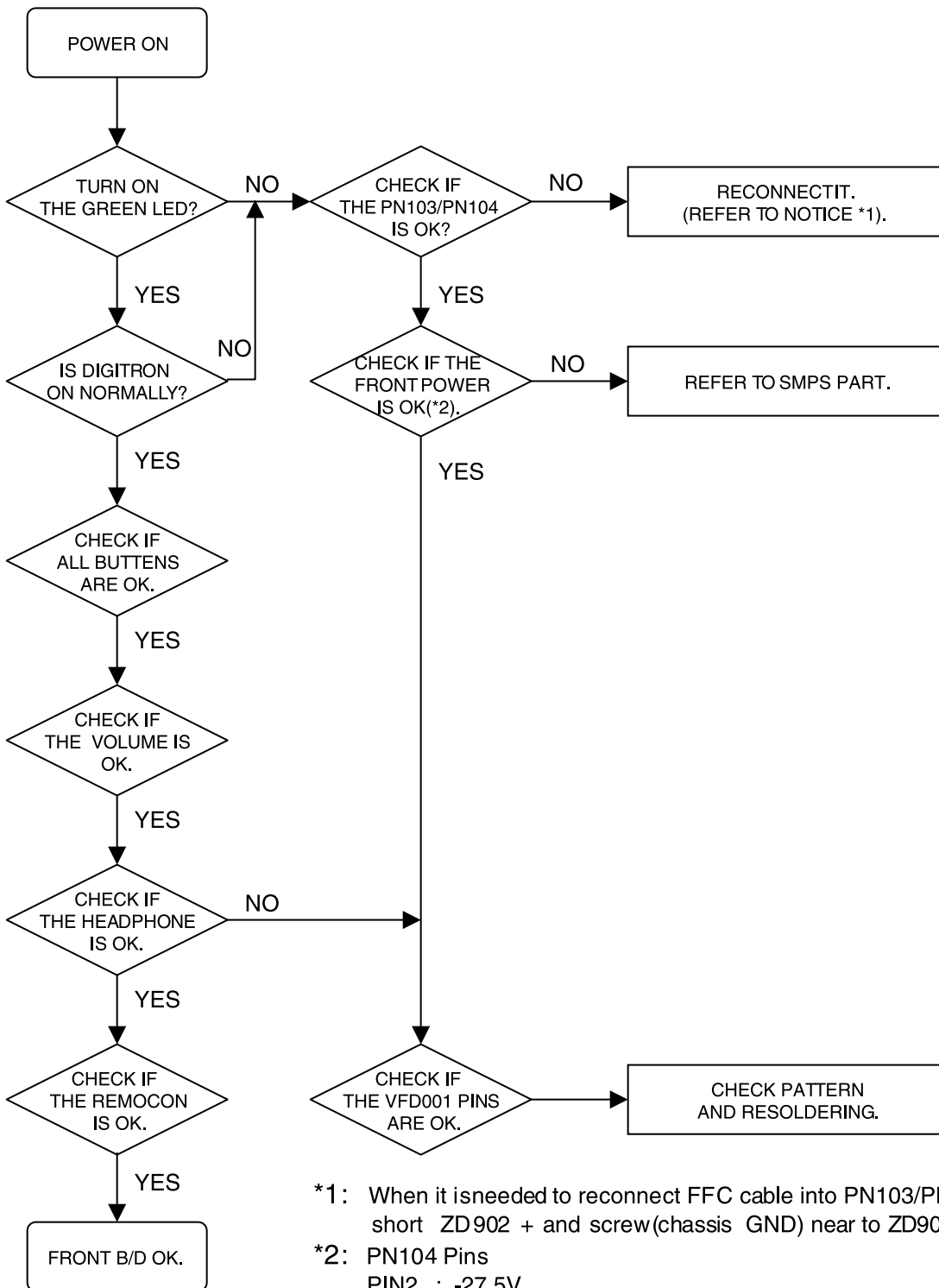
1. Power check flow



2.AUDIO μ.COM CIRCUIT



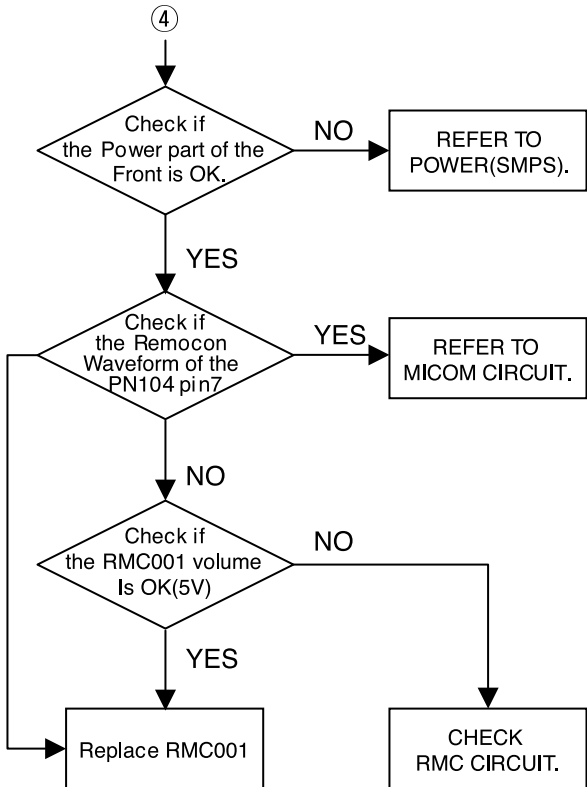
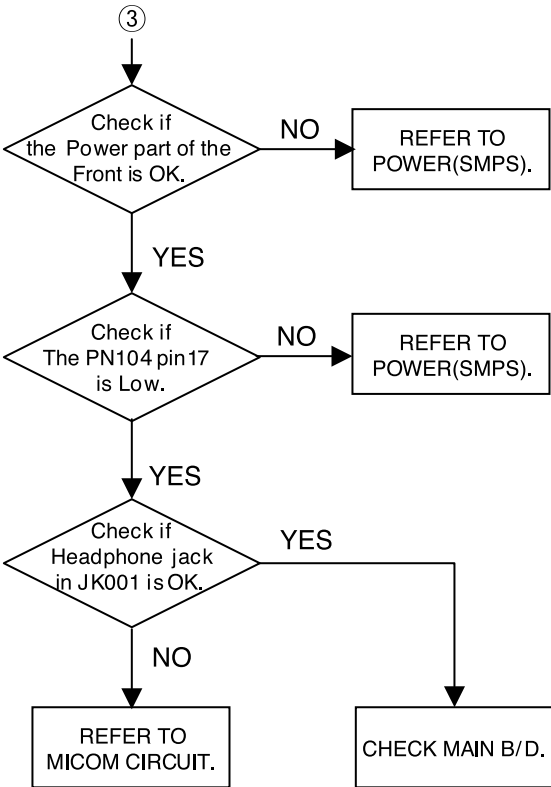
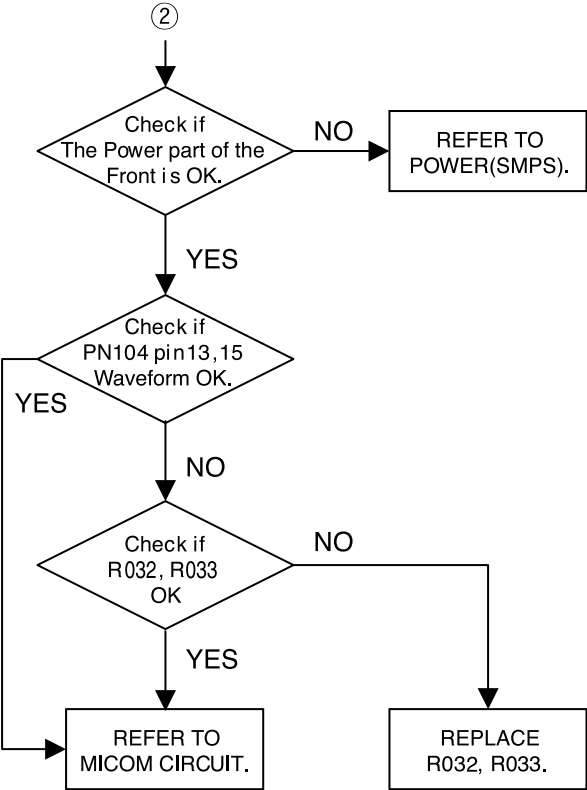
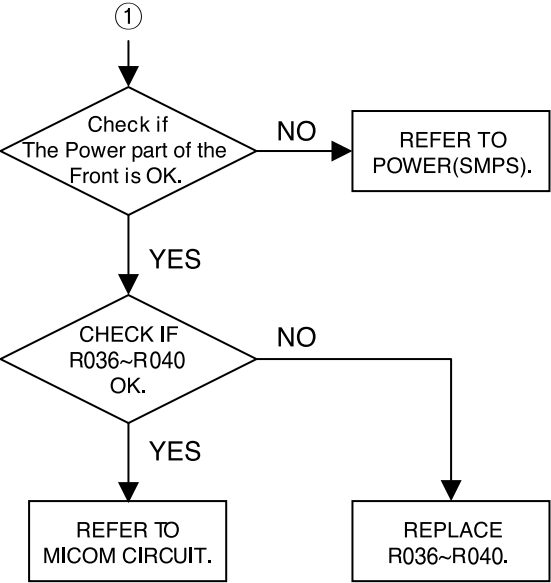
3.FRONT CIRCUIT (1/2)



*1: When it is needed to reconnect FFC cable into PN103/PN104, short ZD902 + and screw(chassis GND) near to ZD902.

*2: PN104 Pins
 PIN2 : -27.5V
 PIN3 : -23.0V
 PIN4 : 5.0V
 PIN11 : -34.0V

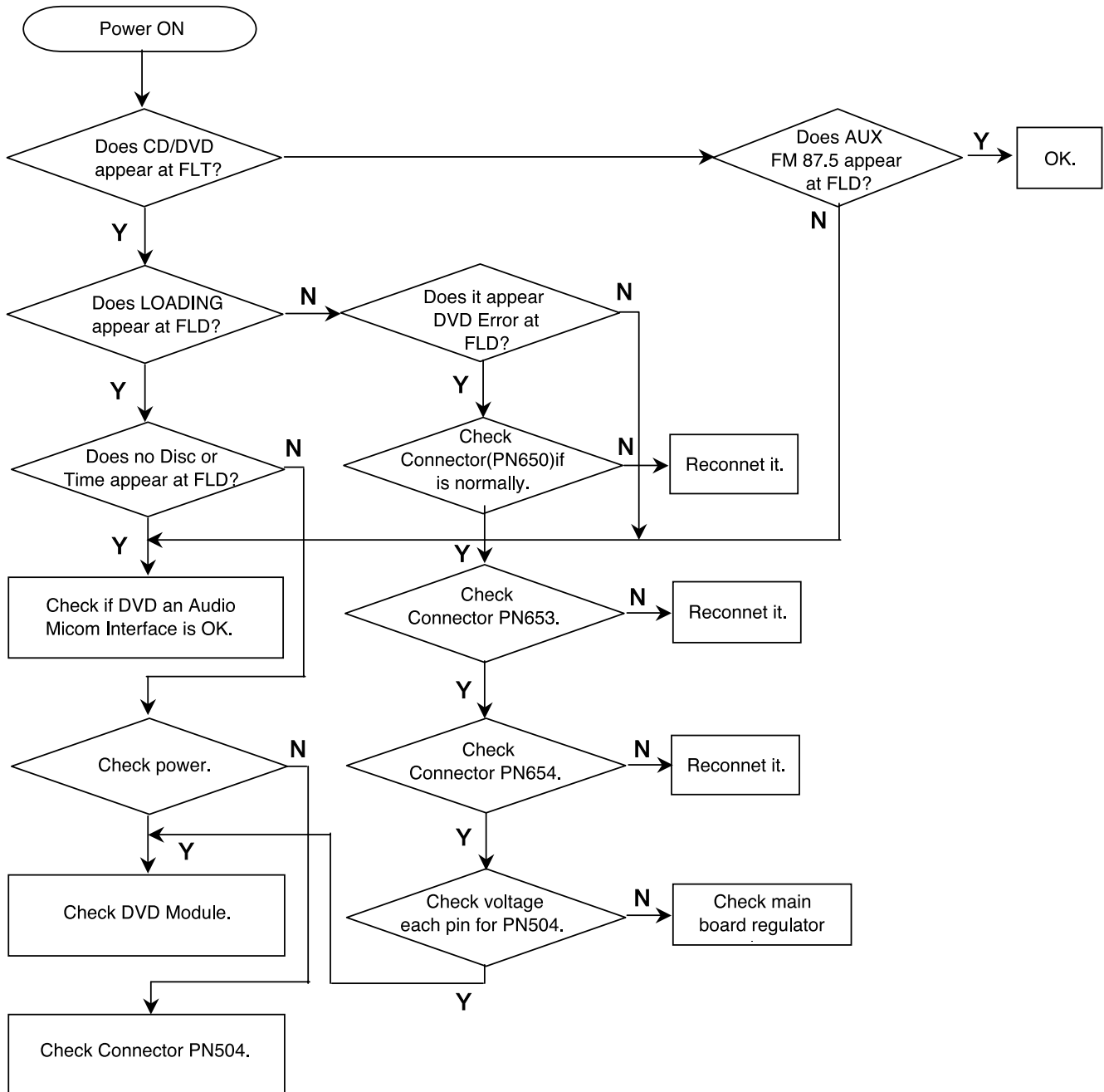
4.FRONT CIRCUIT (2/2)



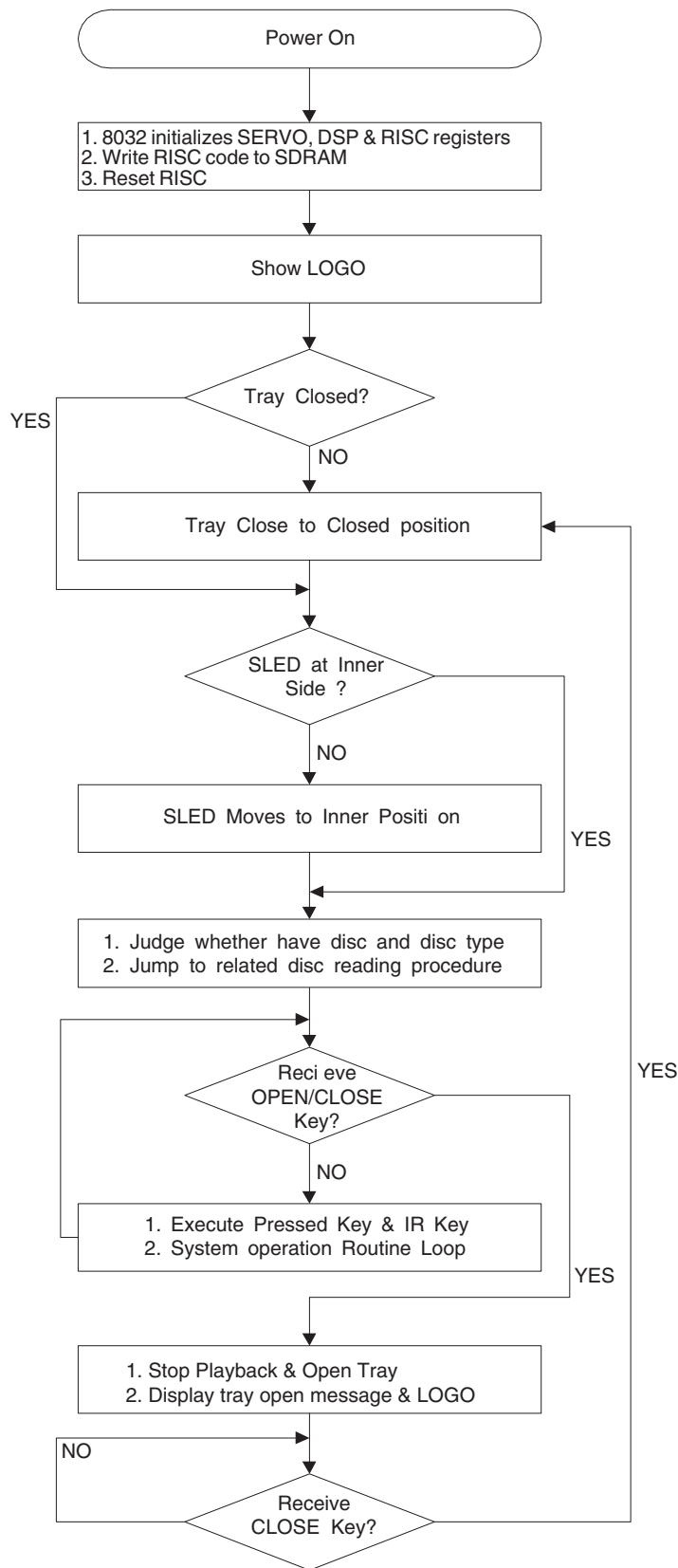
SECTION 3. DVD PART

□ ELECTRICAL TROUBLESHOOTING GUIDE

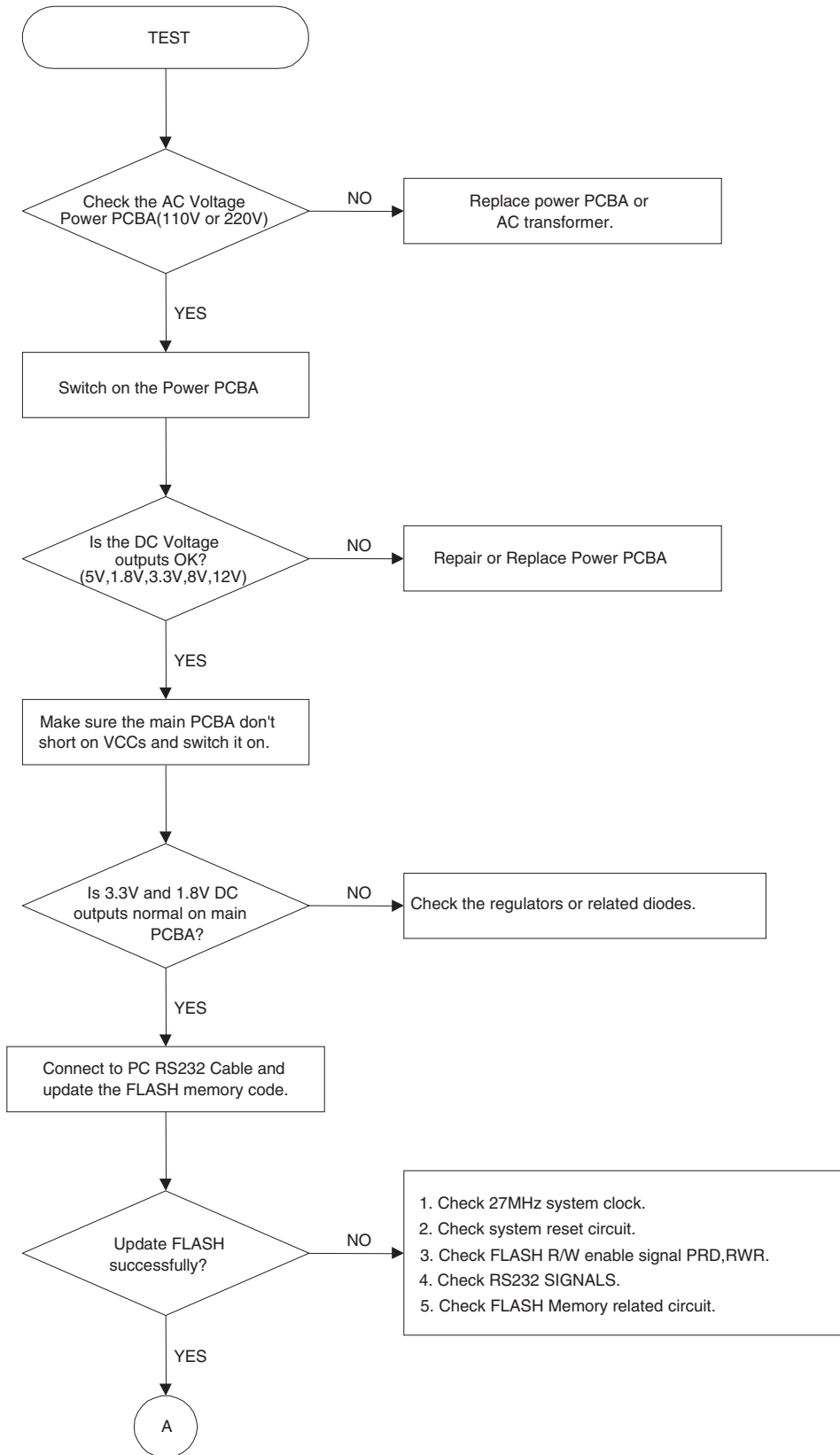
1. Power check flow

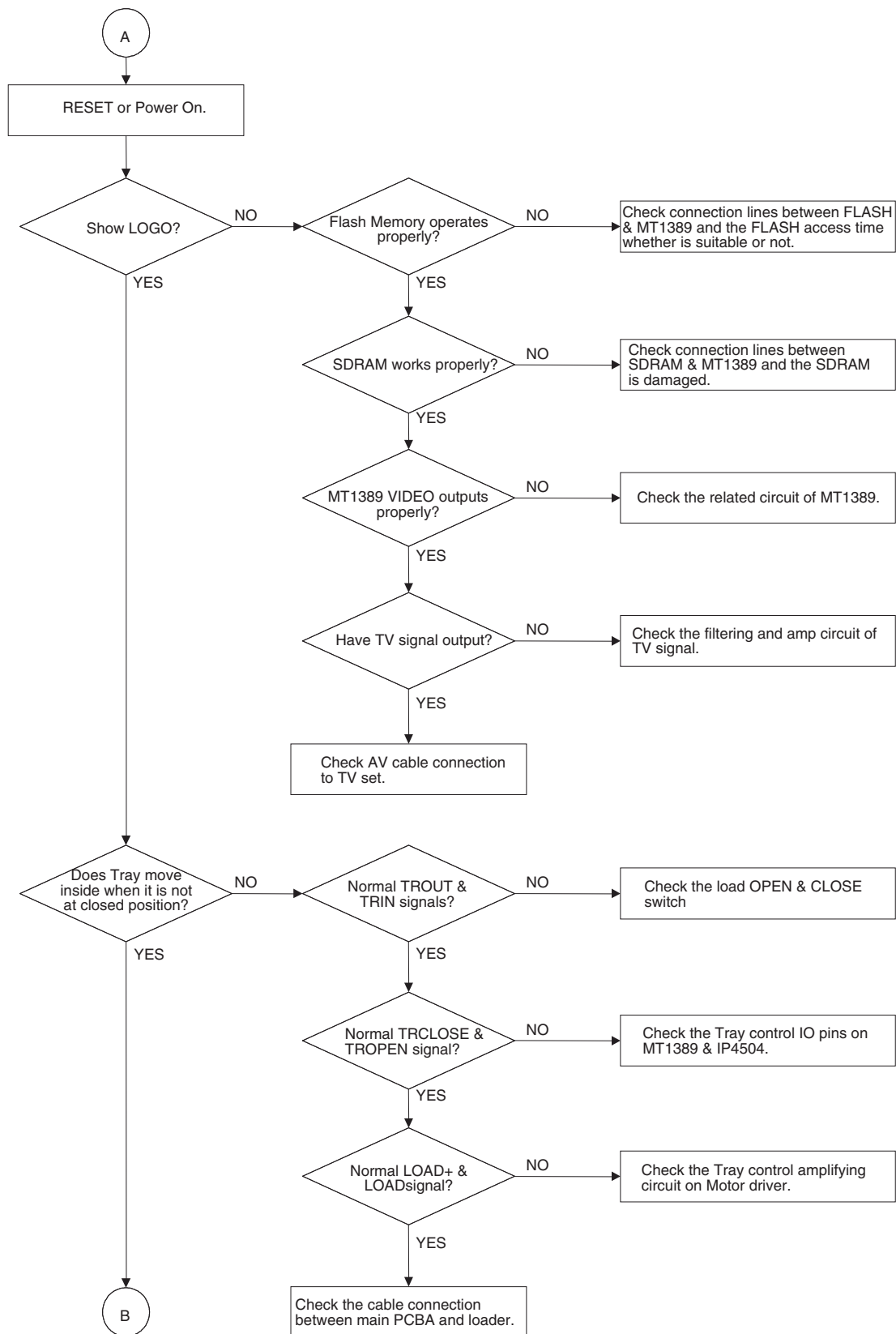


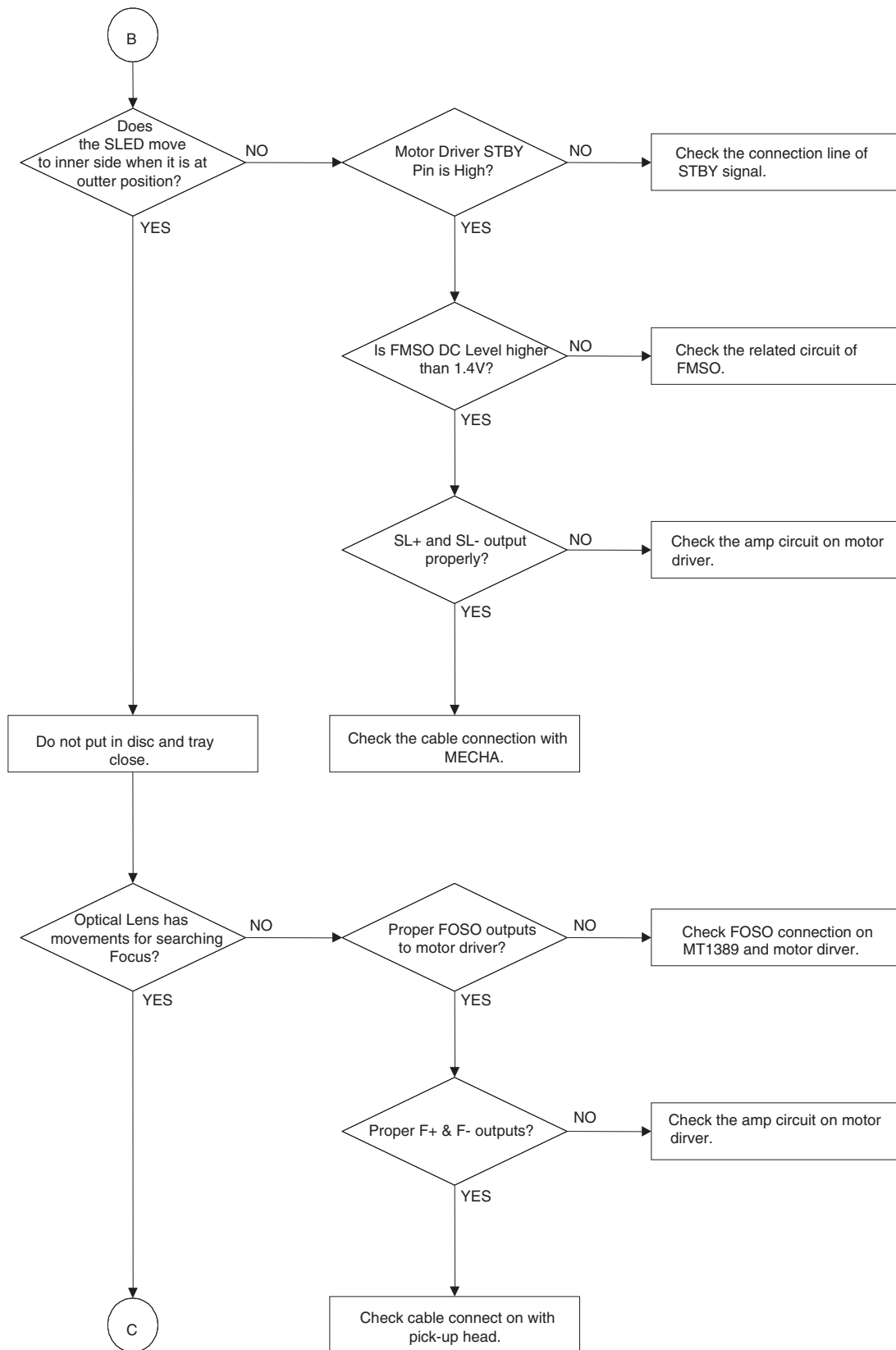
2. System operation flow

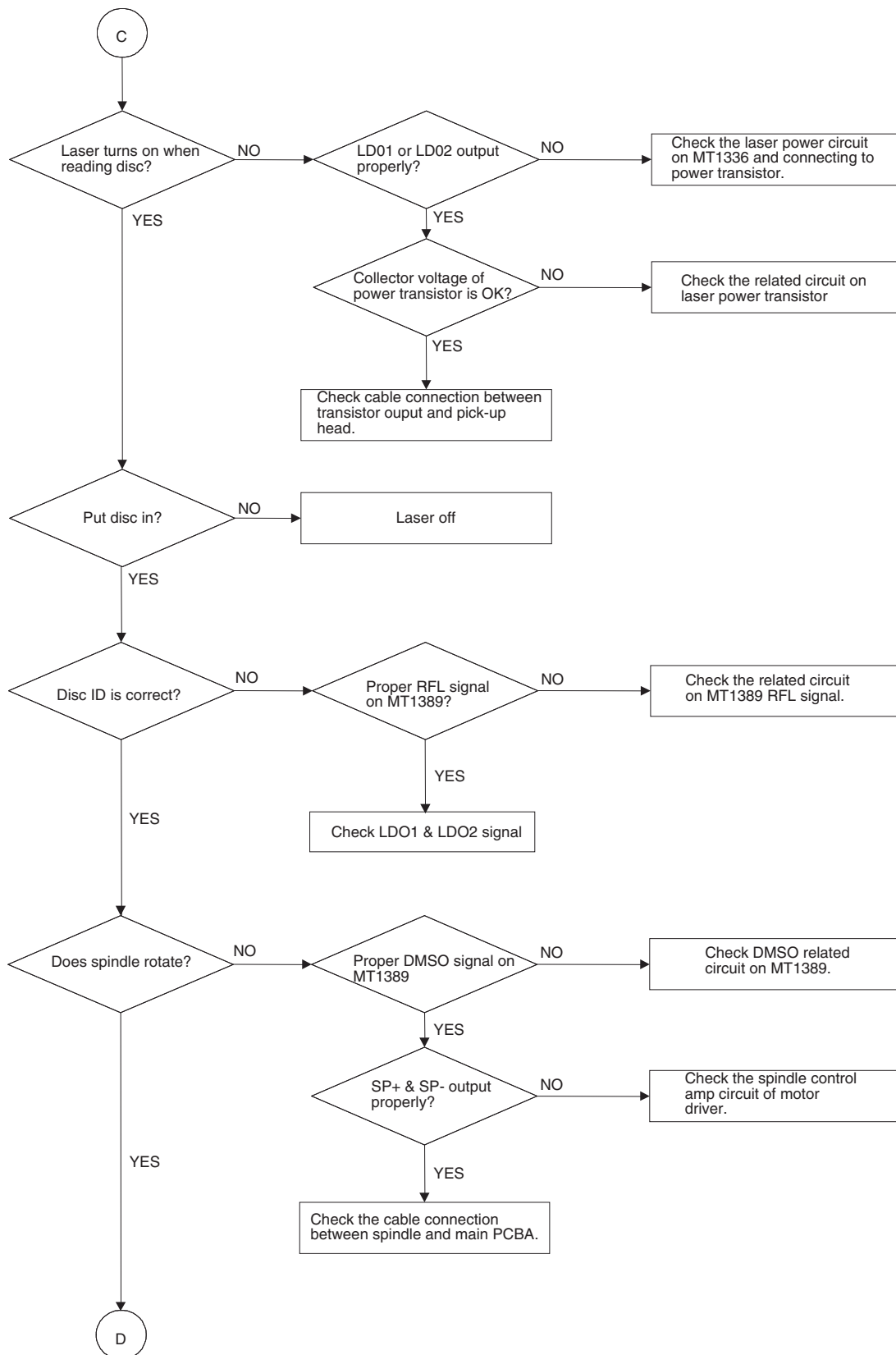


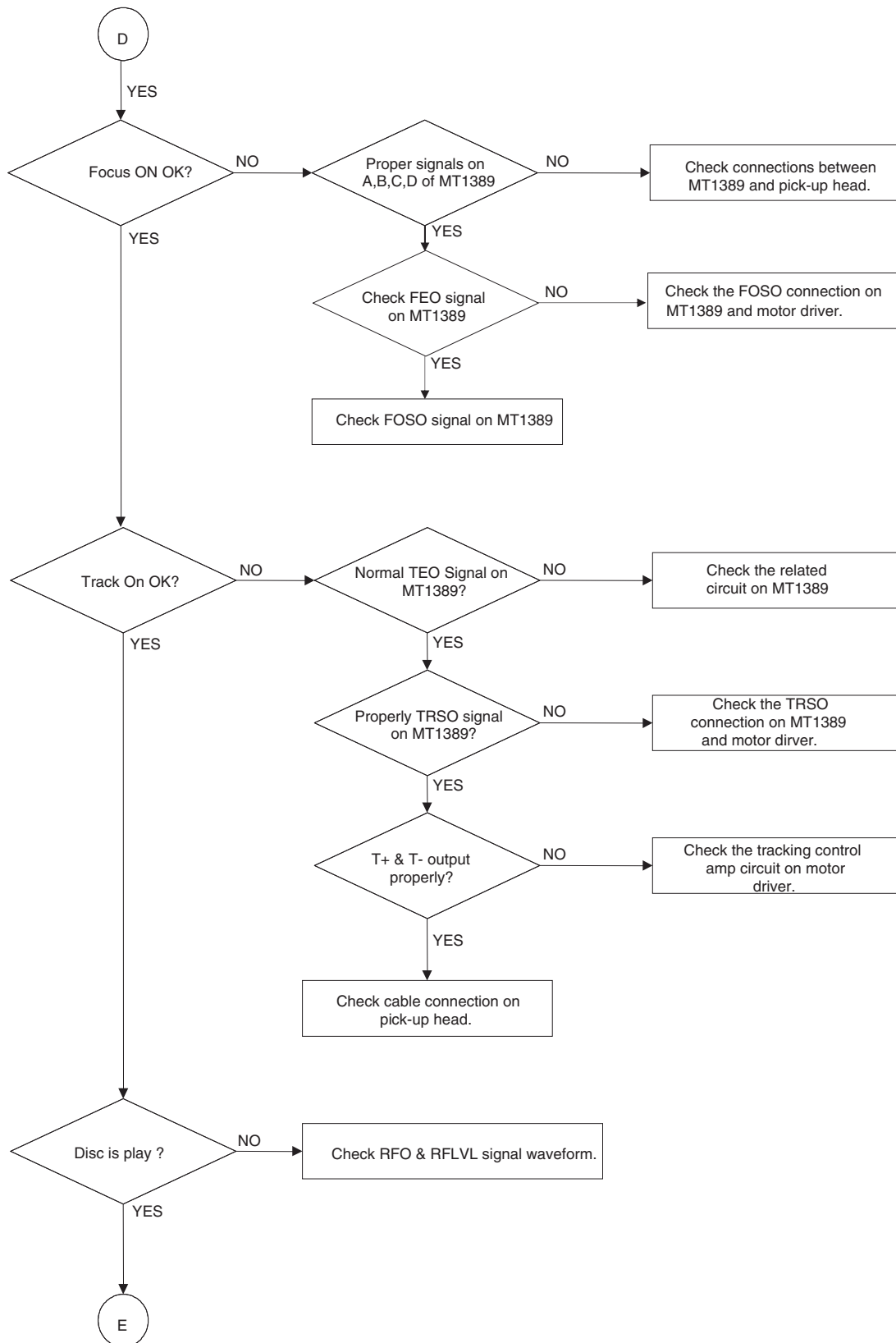
3. Test & debug flow

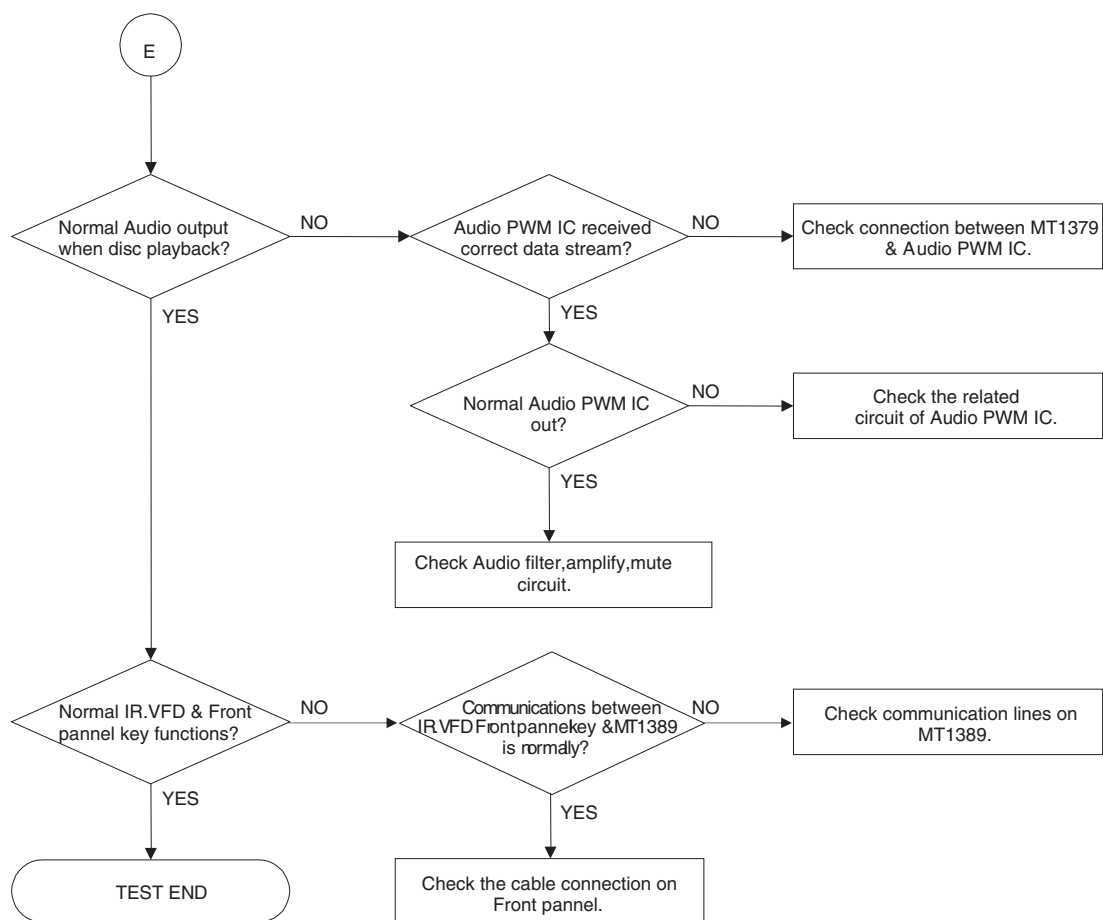












❑ DETAILS AND WAVEFORMS ON SYSTEM TEST AND DEBUGGING

1. SYSTEM 27MHz CLOCK,RESET,FLASH R/W SIGNAL

1) MT1379 main clock is at 27MHz(X501)

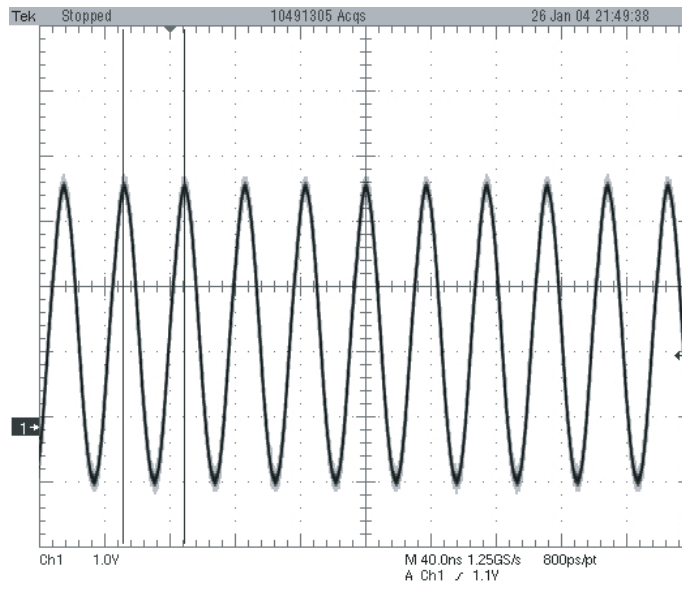


FIG 1-1

2) MT1336 reset is high active

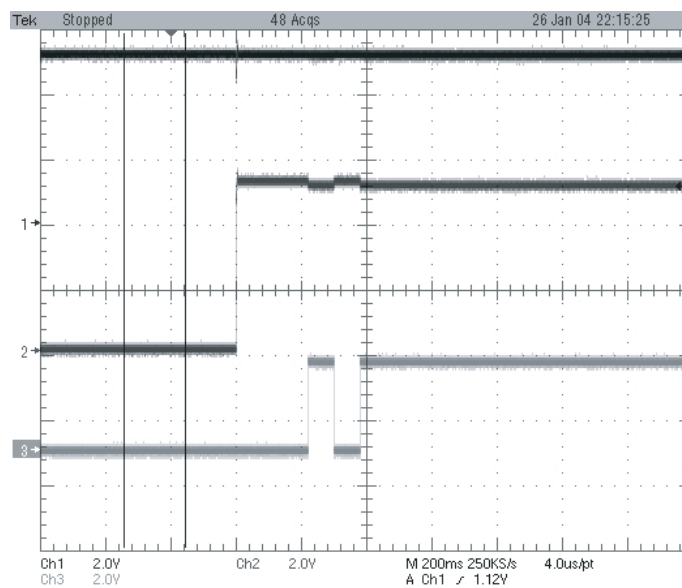


FIG 1-2

3) RS232 waveform during procedure(Downloading)

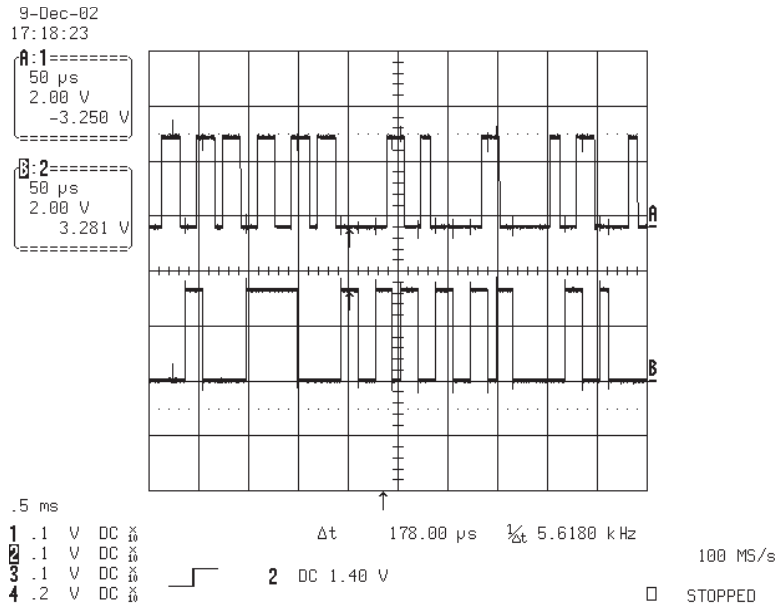


FIG 1-3

4) Flash R/W enable signal during download(Downloading)

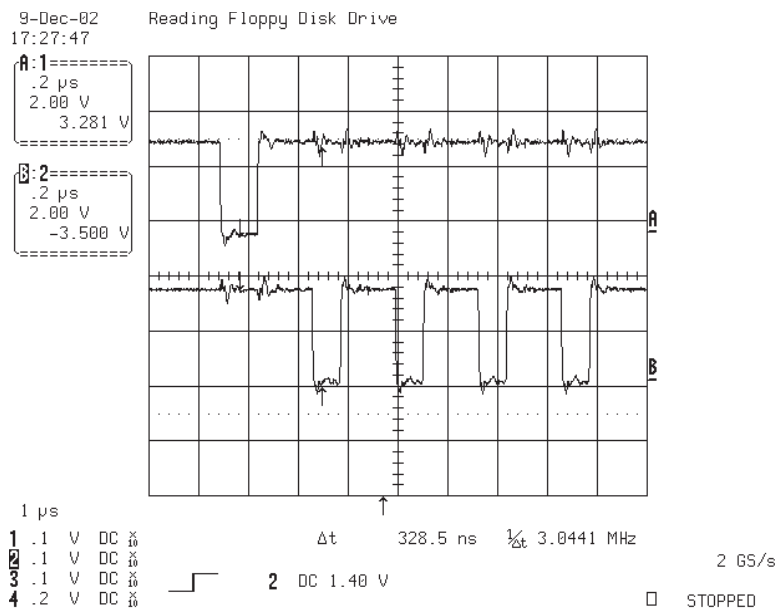


FIG 1-4

2. SDRAM CLOCK

1) MT1379 main clock is at 27MHz(X501)

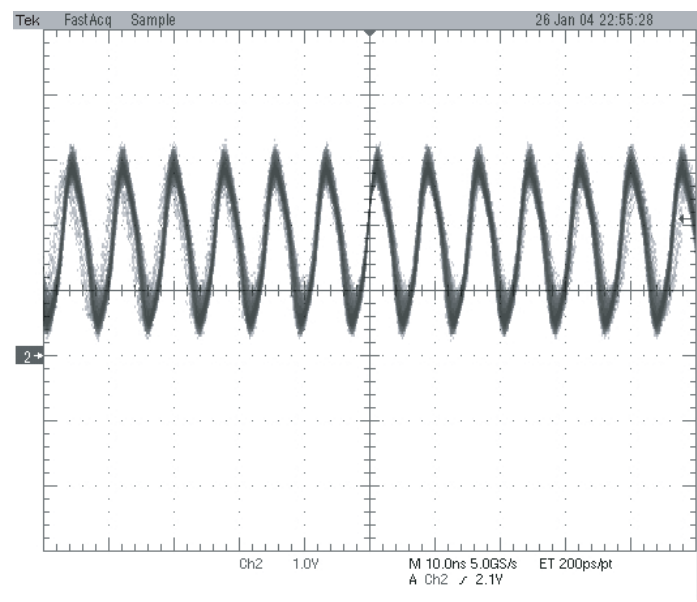


FIG 2-1

3. TRAY OPEN/CLOSE SIGNAL

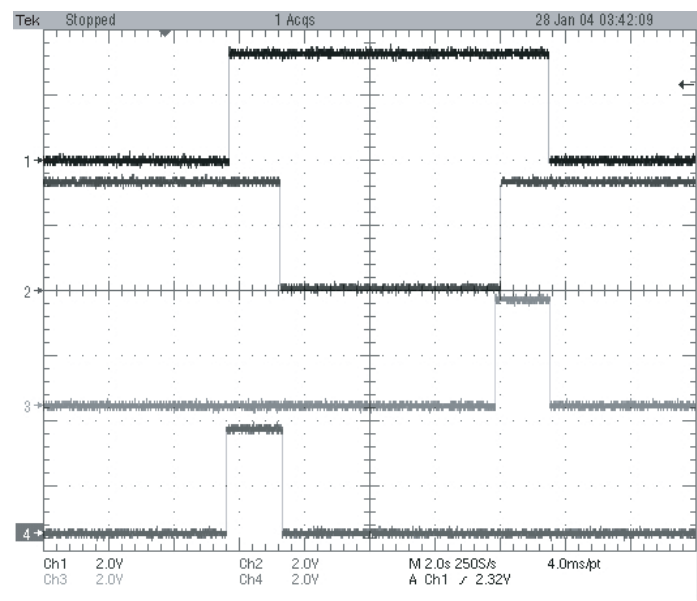


FIG 3-1

4. SLED CONTROL RELATED SIGNAL (NO DISC CONDITION)

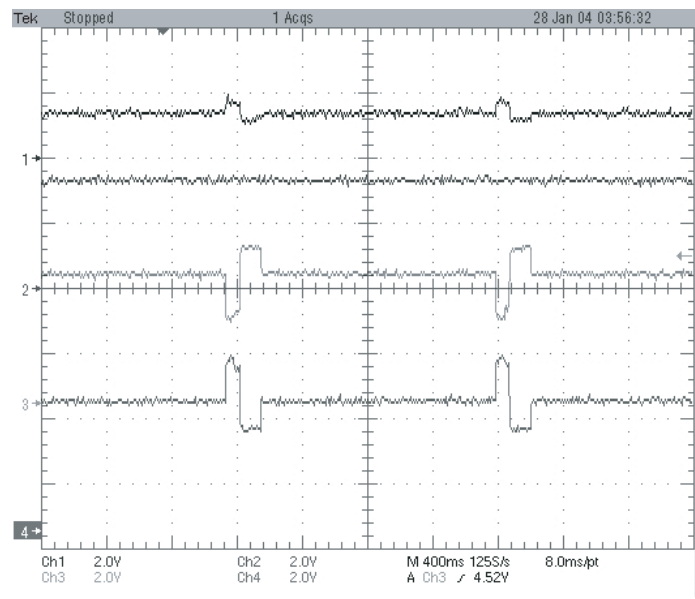


FIG 4-1

5. LENS CONTROL RELATED SIGNAL(NO DISC CONDITION)

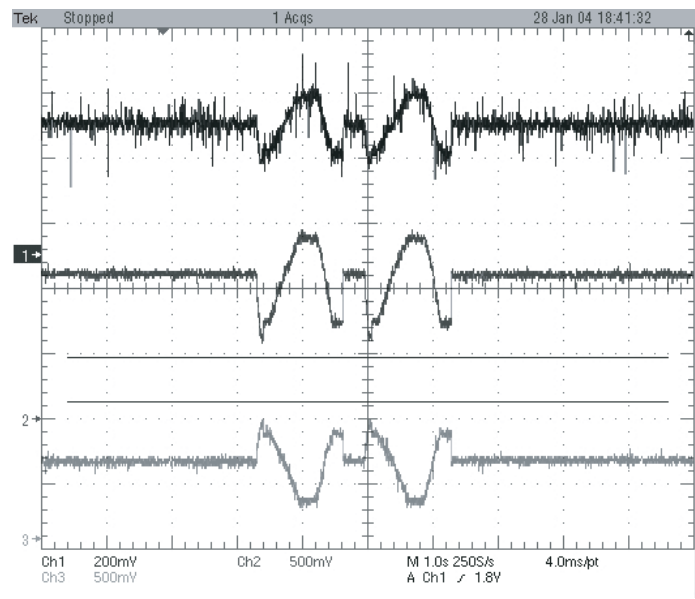


FIG 5-1

6. LASER POWER CONTROL RELATED SIGNAL
(NO DISC CONDITION)

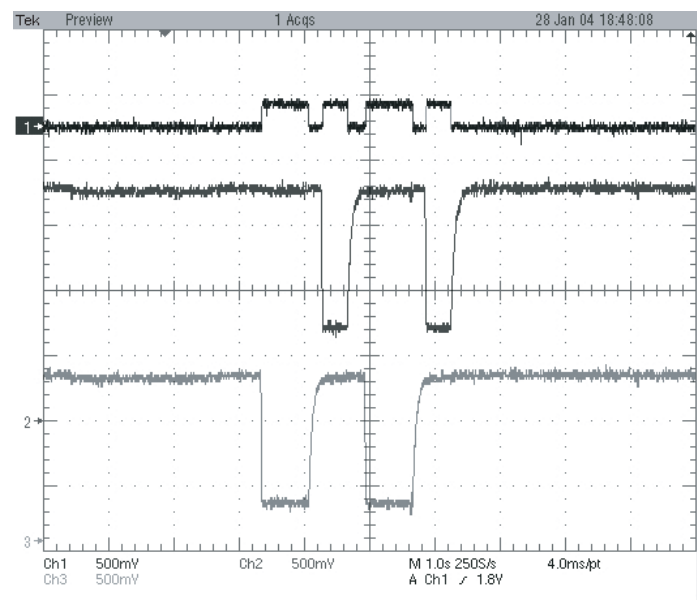


FIG 6-1

7. DISC TYPE JUDGEMENT W VEFORM

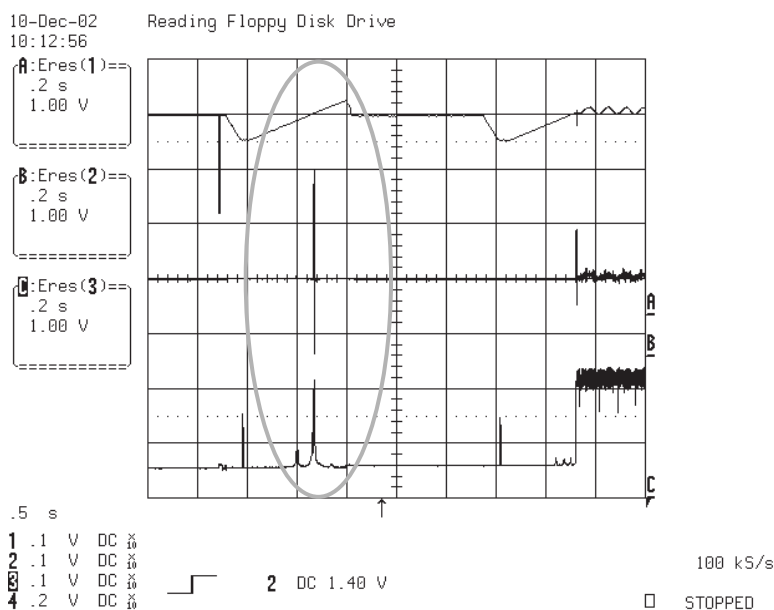


FIG 7-1

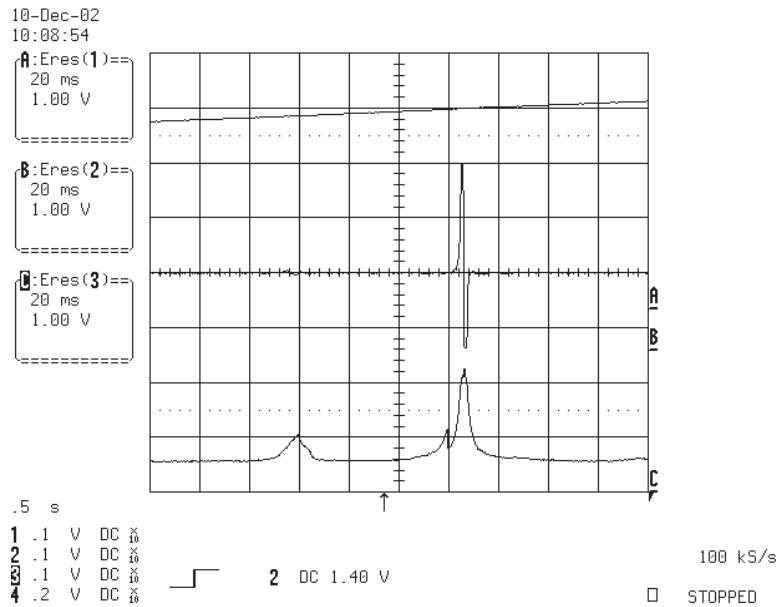


FIG 7-2 (DVD)

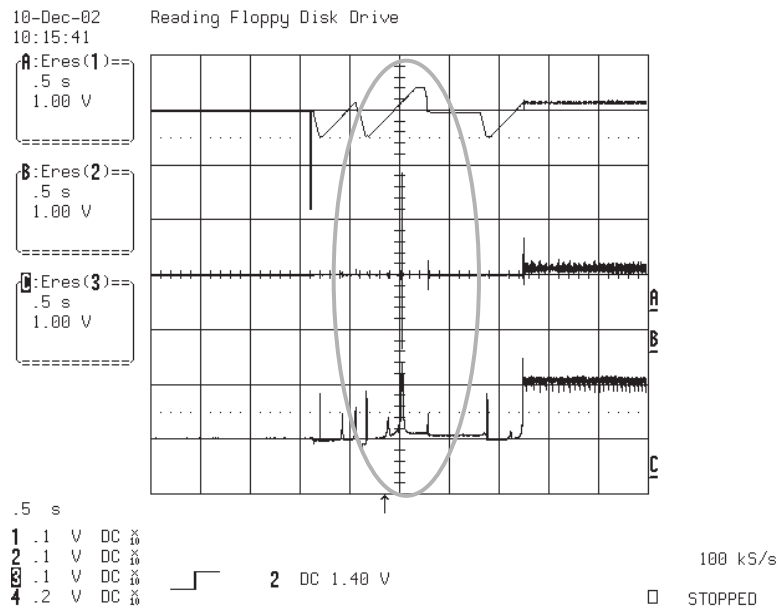


FIG 7-3 (CD)

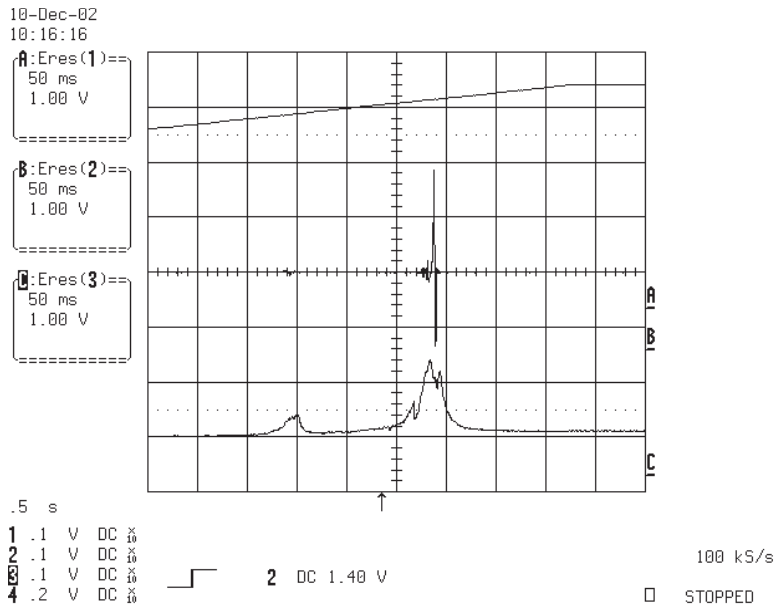


FIG 7-4 (CD)

8. FOCUS ON W VEFORM

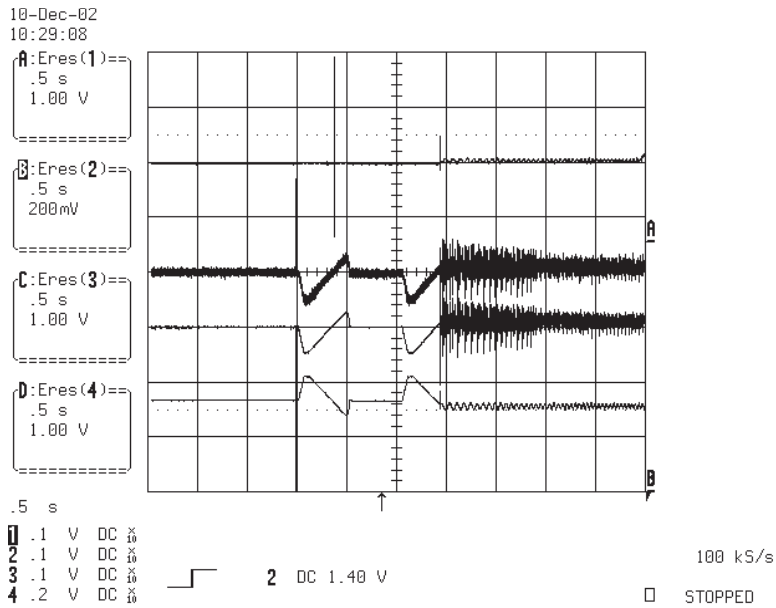


FIG 8-1 (DVD)

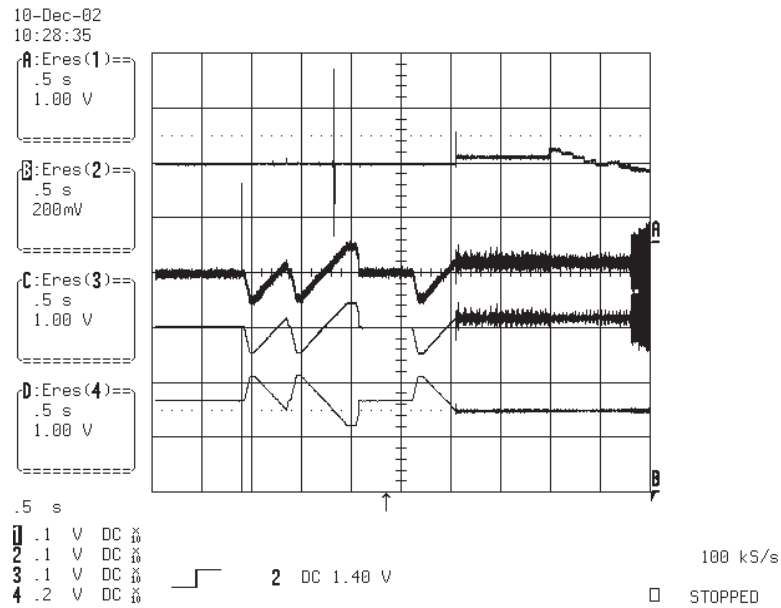


FIG 8-2 (CD)

9. SPINDLE CONTROL W VEFORM (NO DISC CONDITION)

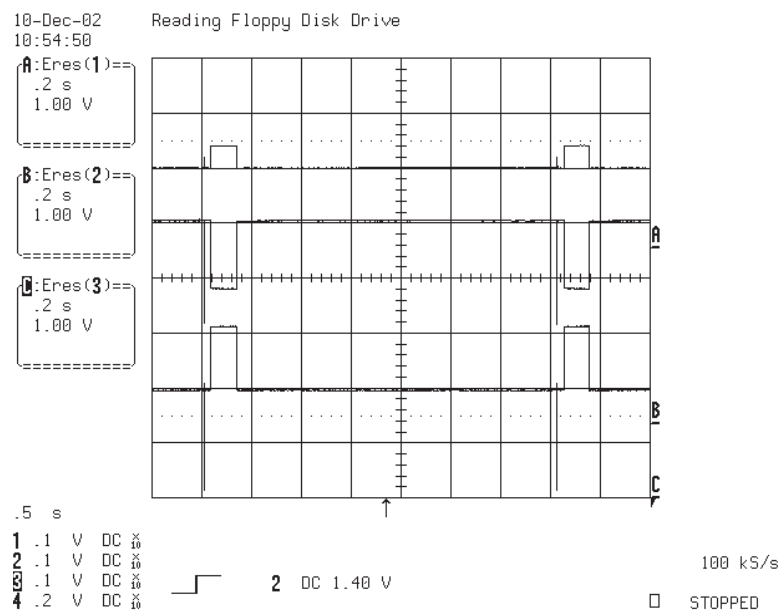


FIG 9-1

10. TRACKING CONTROL RELATED SIGNAL(System checking)

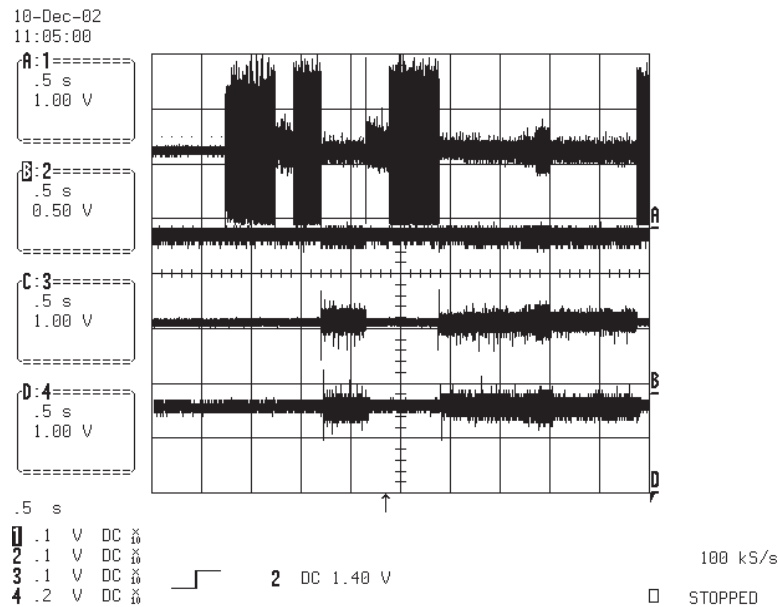


FIG 10-1 (DVD)

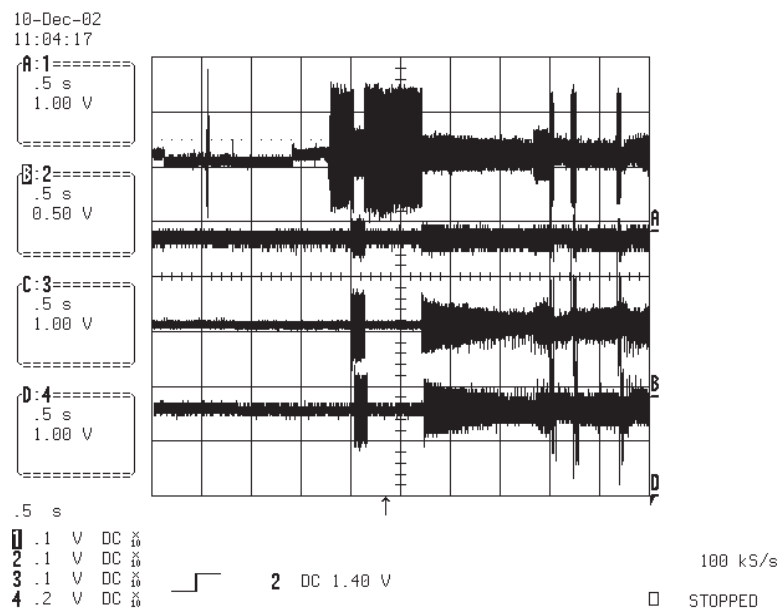


FIG 10-2 (CD)

11. MT1389 AUDIO OPTICAL AND COAXIAL INPUT (SPDIF)

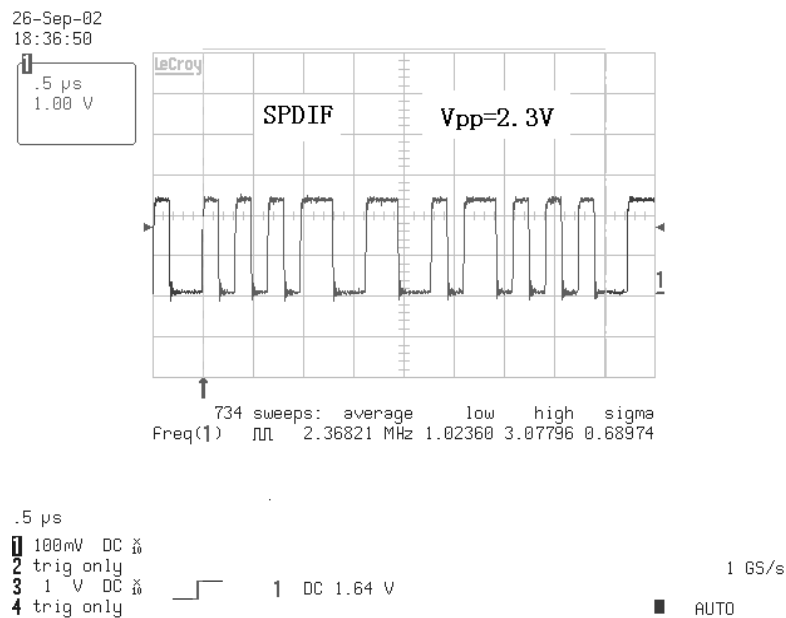


FIG 11-1 (DVD)

12. MT1389 VIDEO OUTPUT WAVEFORM

1)100%

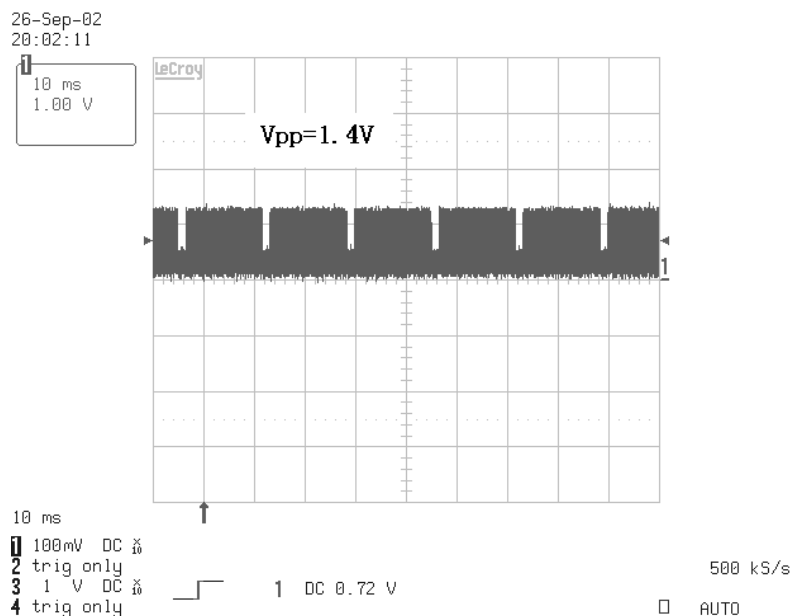


FIG 12-1

2) COMPOSITE VIDEO SIGNAL

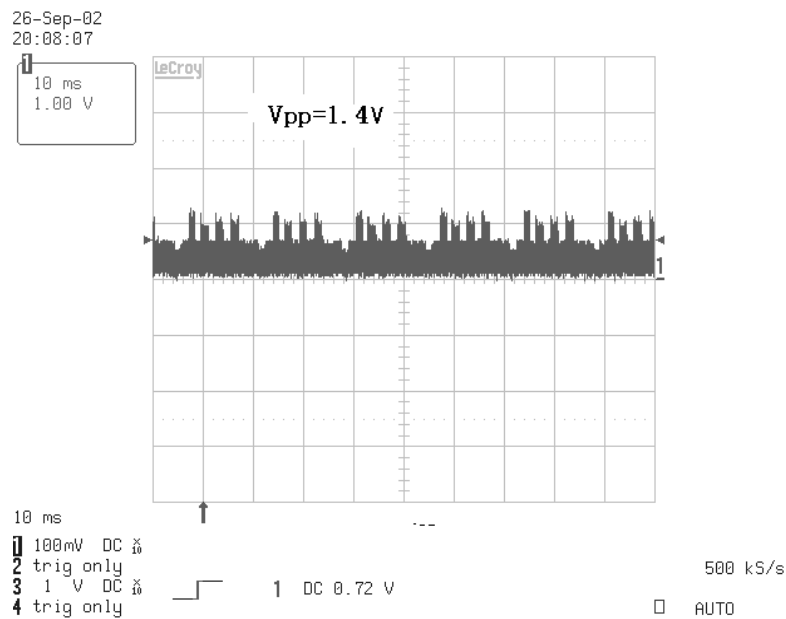


FIG 12-2

13. MT1389 AUDIO OUTPUT TO PWM IC

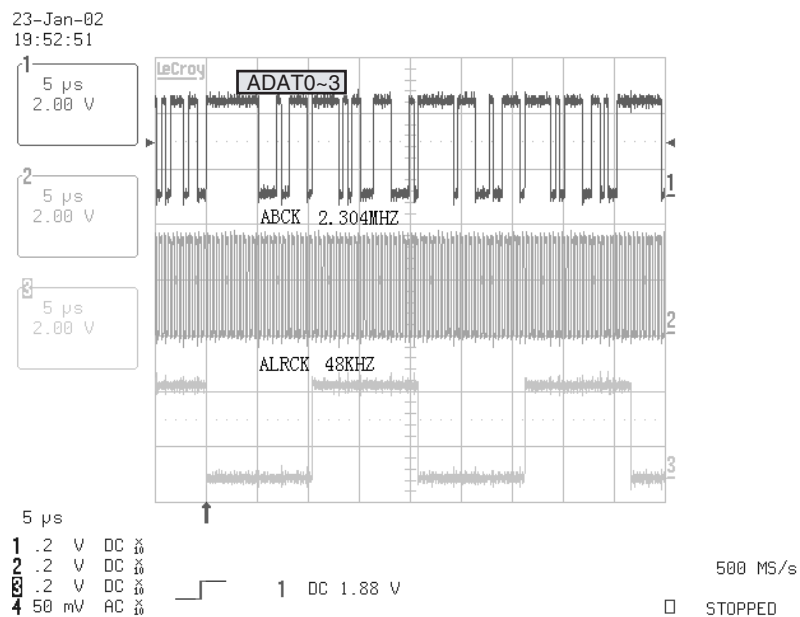


FIG 13-1

14. AUDIO OUTPUT FROM PWM IC

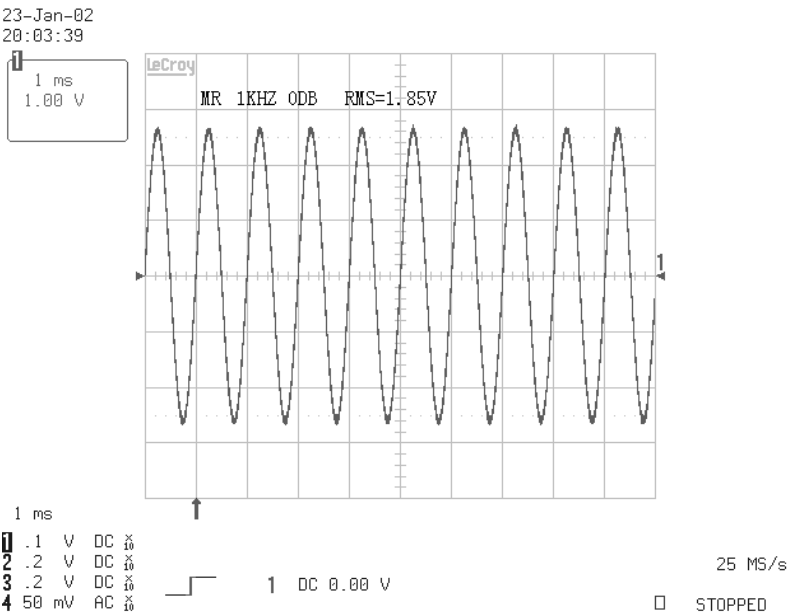
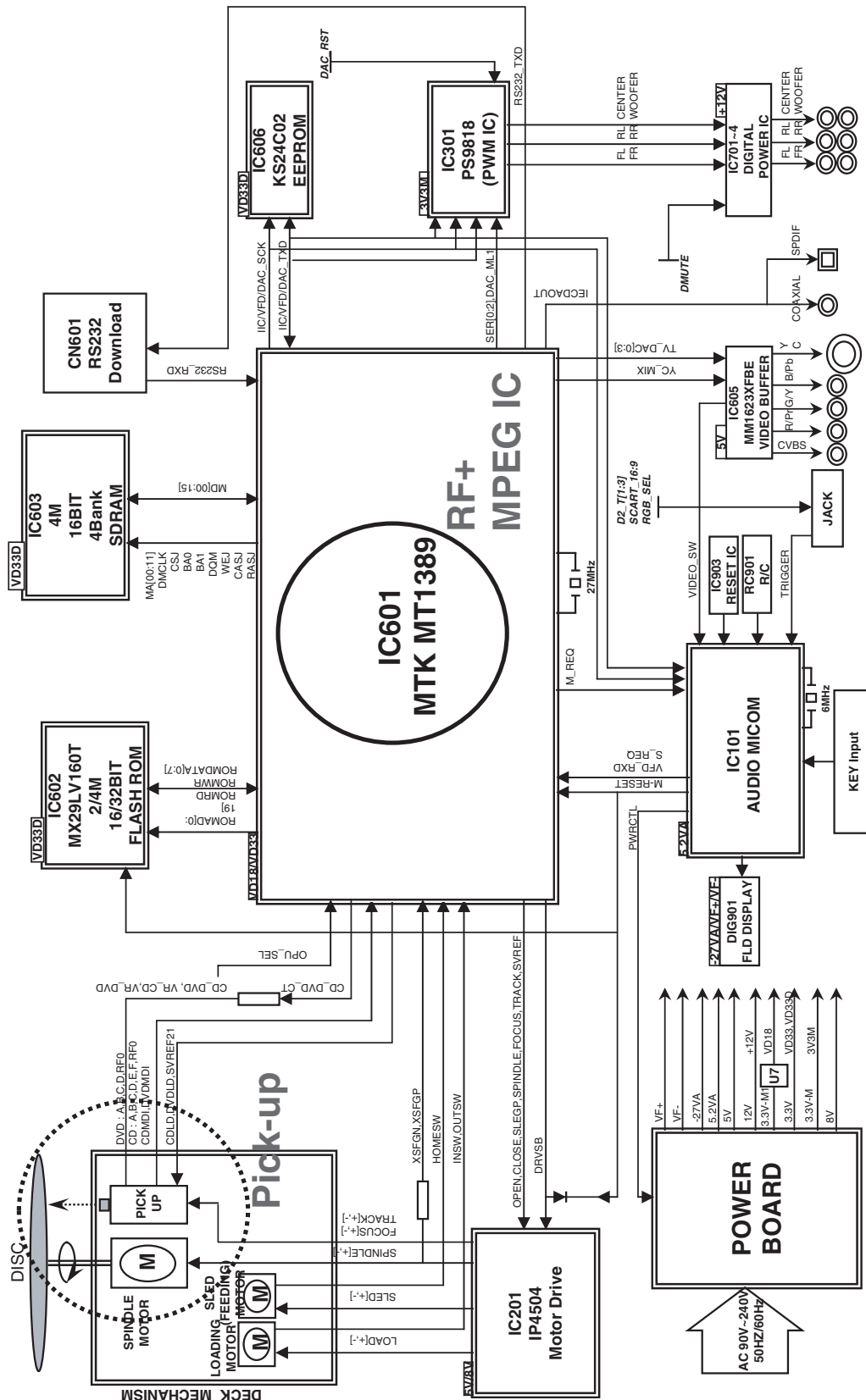


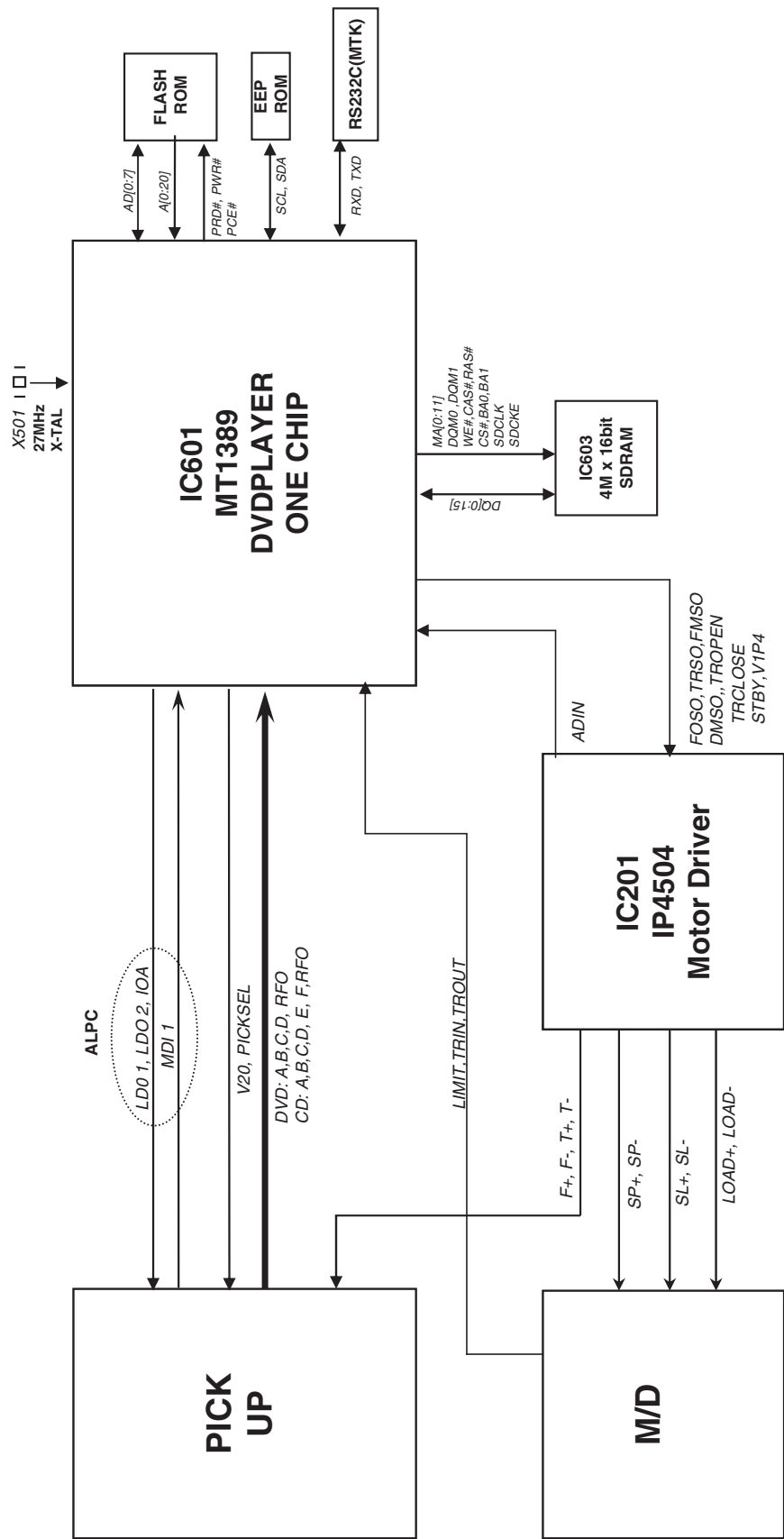
FIG 14-1

□ BLOCK DIAGRAM

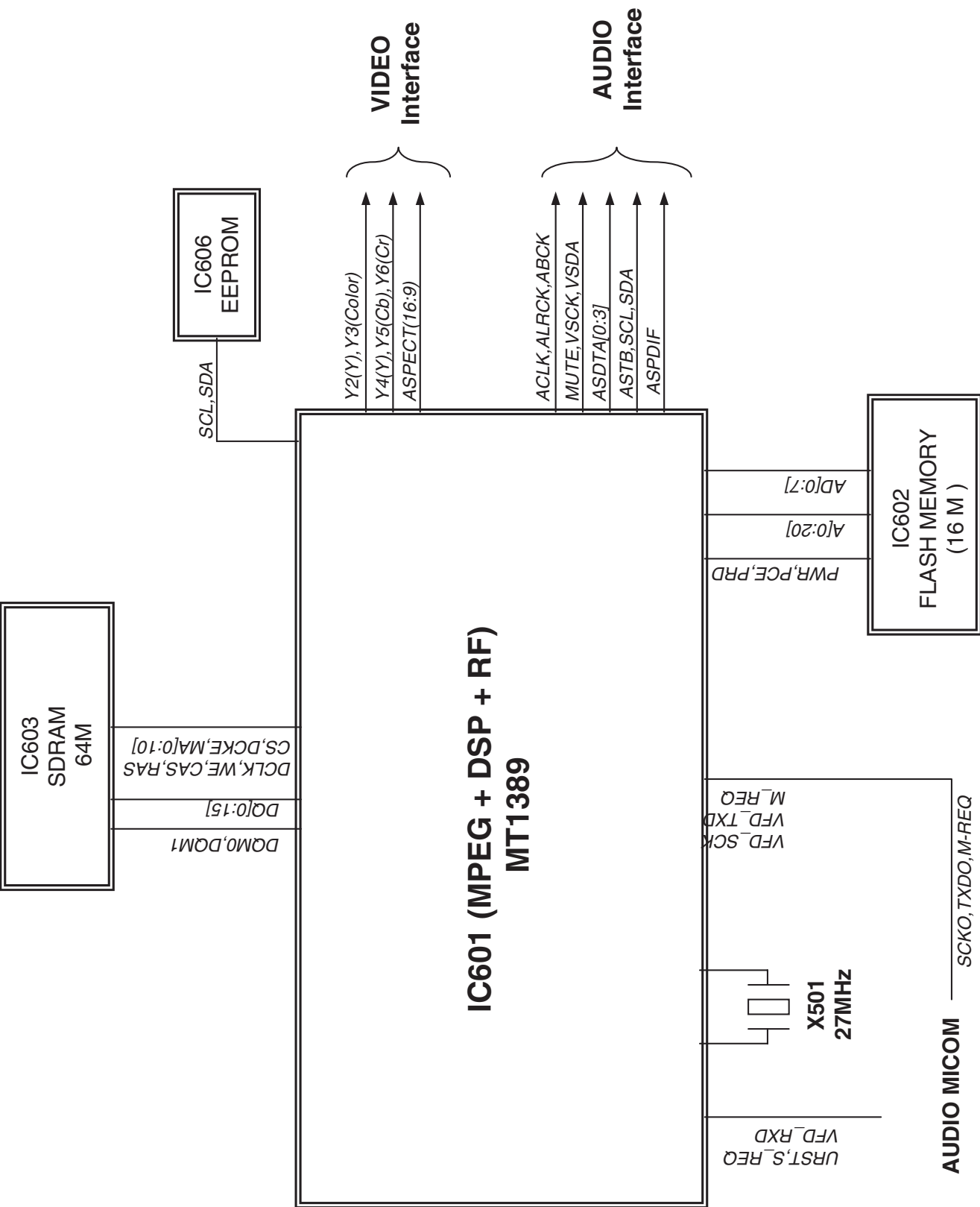
1. Overall Block Diagram



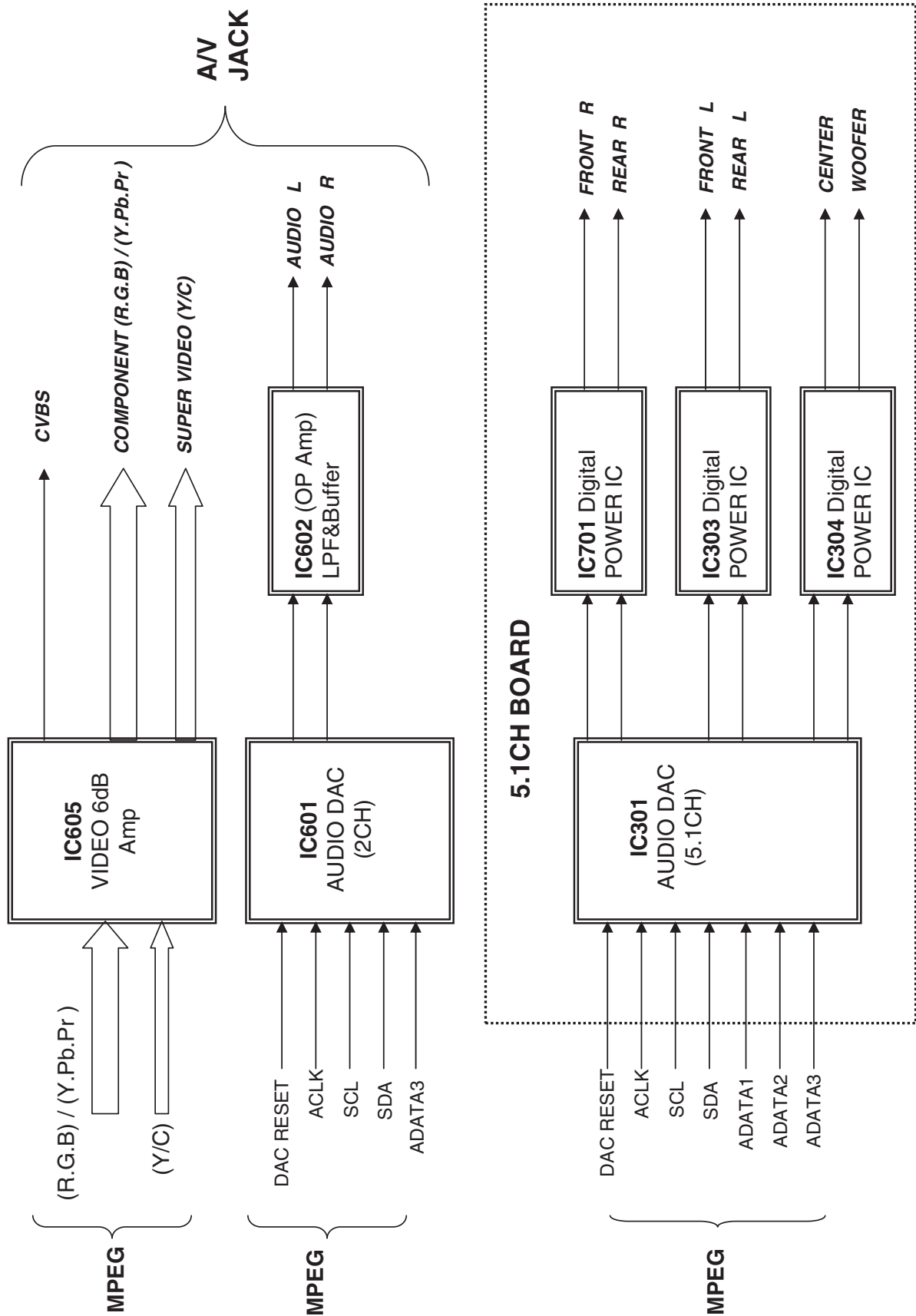
2. SERVO Block Diagram



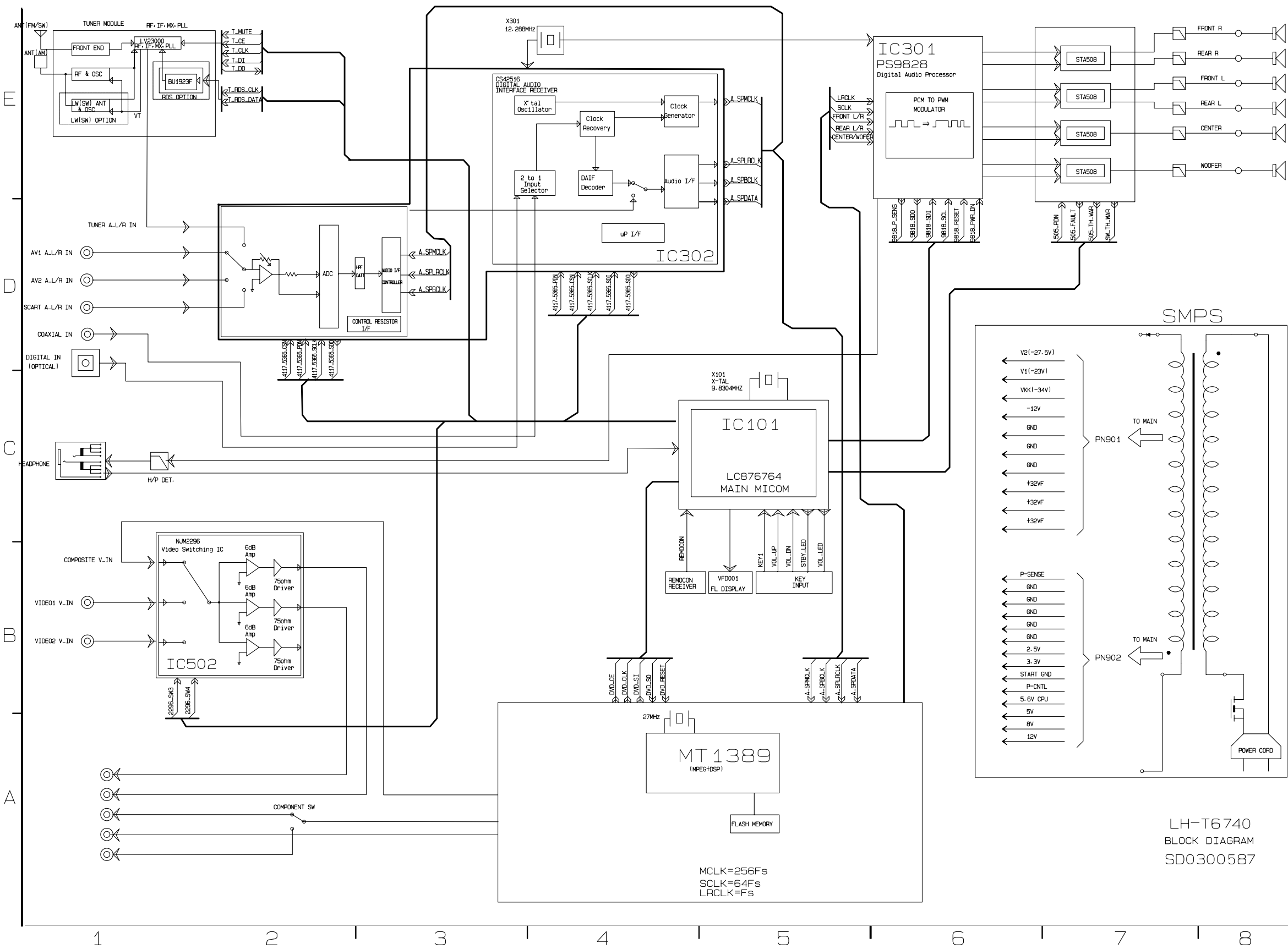
3. MPEG & MEMORY Block Diagram



4. VIDEO & AUDIO Block Diagram

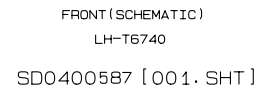


BLOCK DIAGRAM

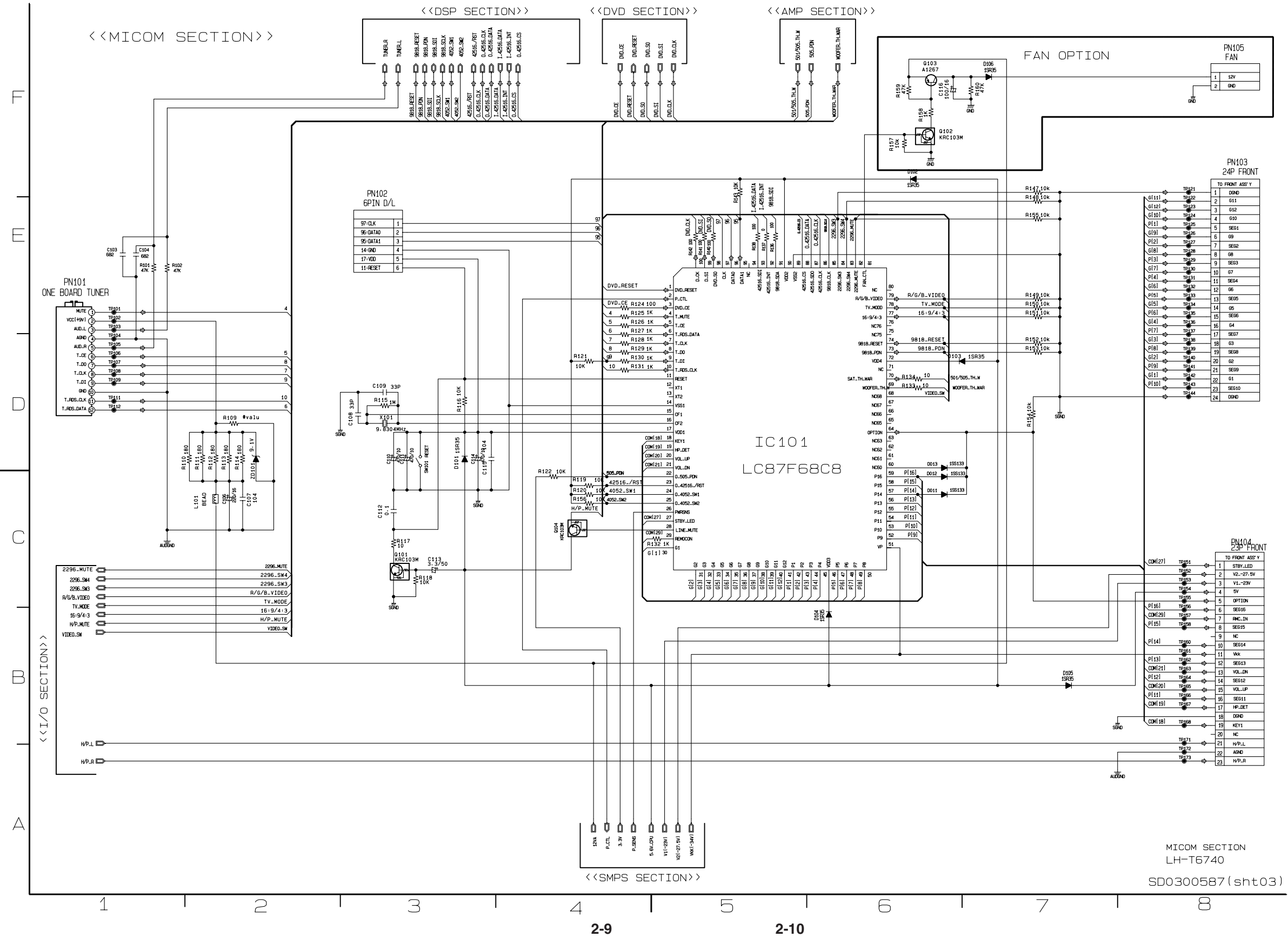


LH-T6740
 BLOCK DIAGRAM
 SD0300587

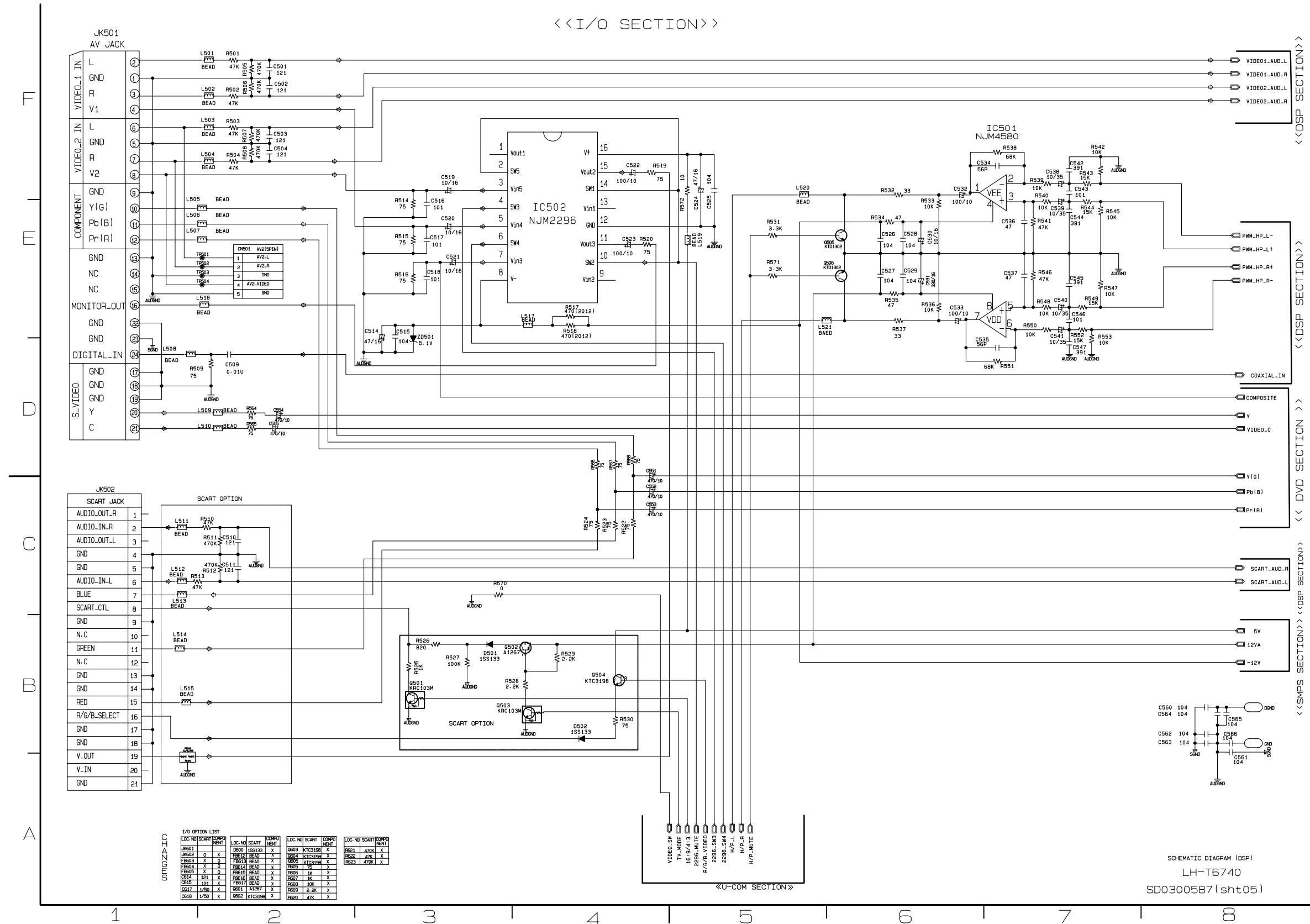
• **FRONT SCHEMATIC DIAGRAM**



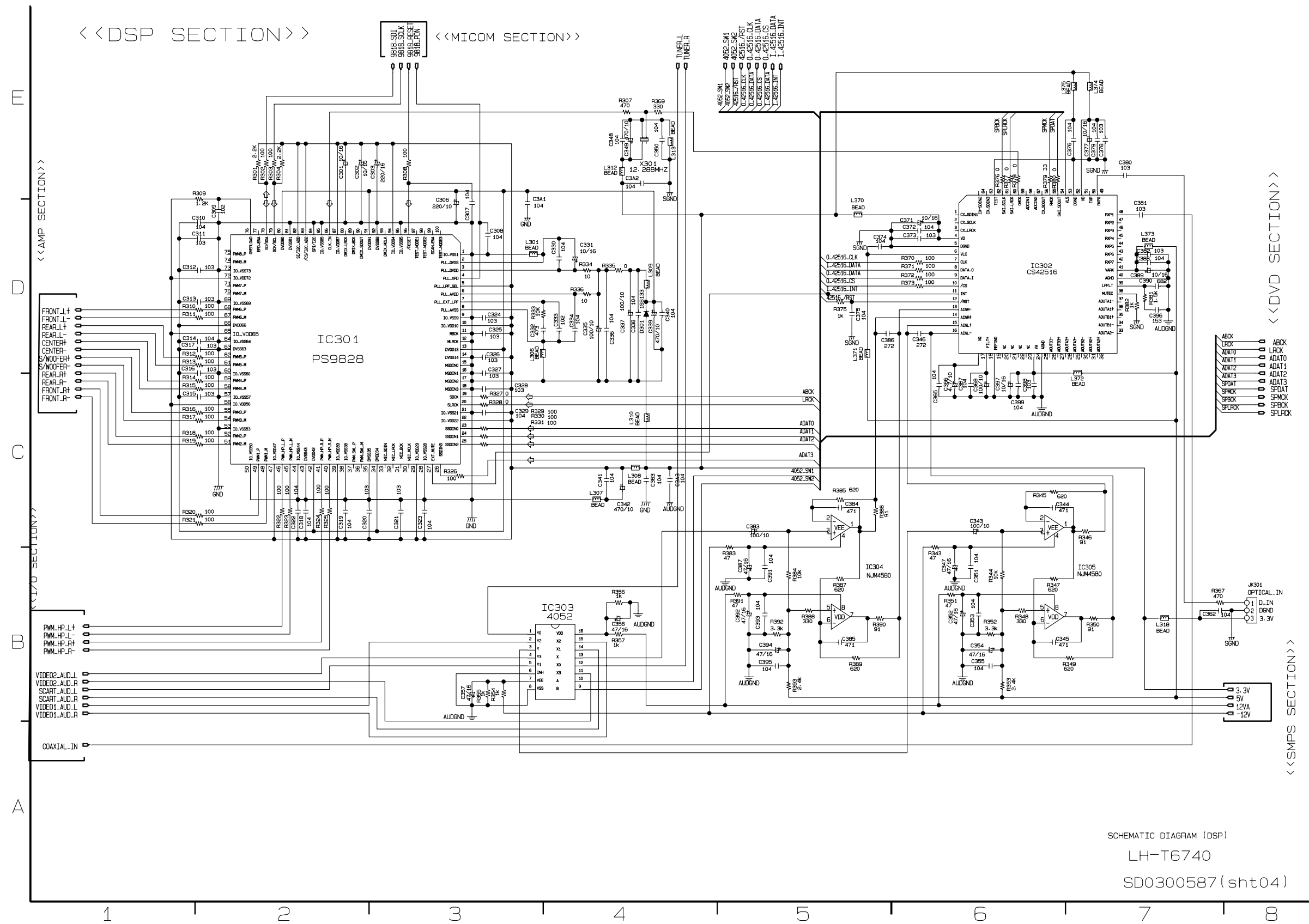
- **MICOM SCHEMATIC DIAGRAM**



- **I/O SCHEMATIC DIAGRAM**

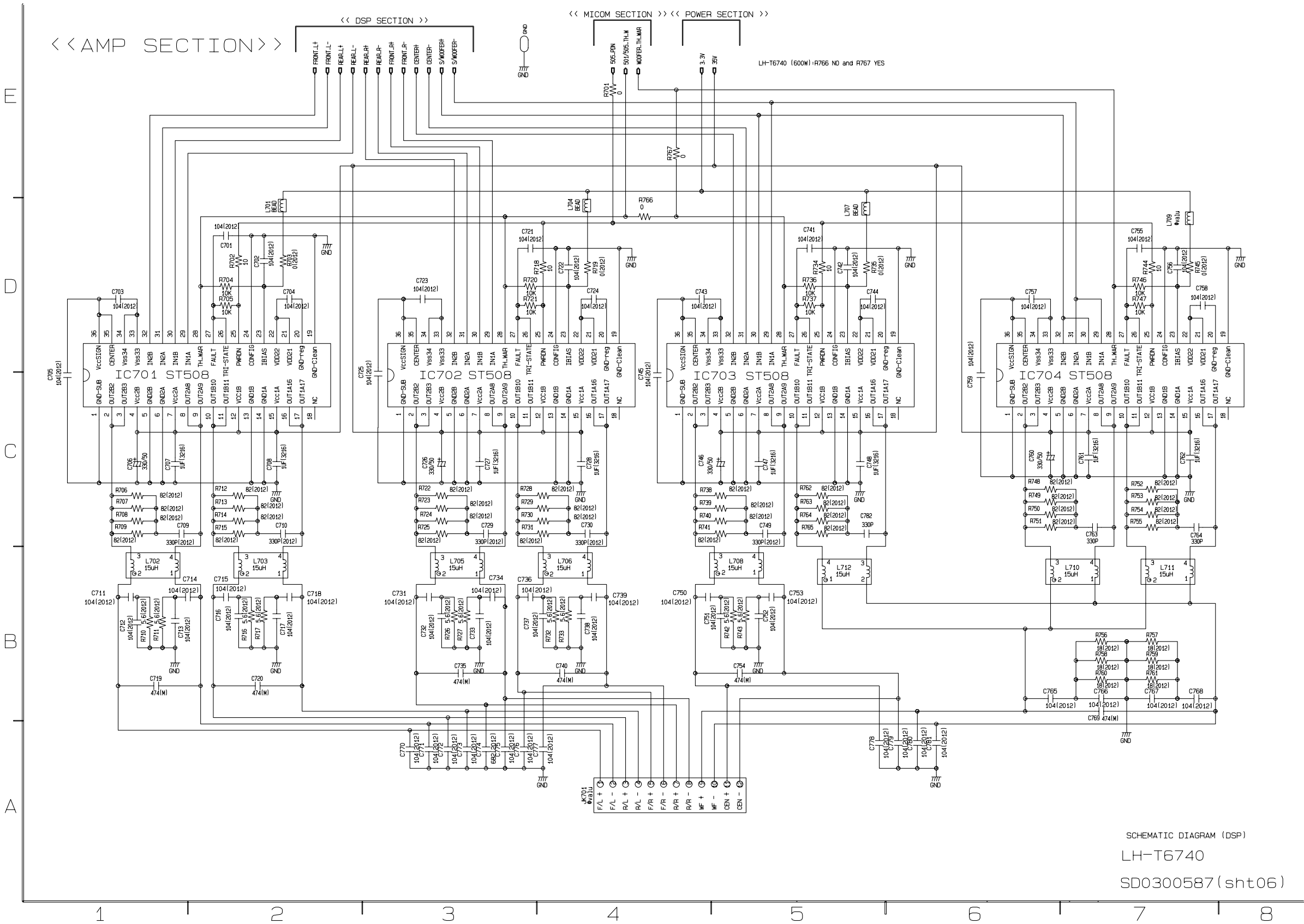


• DSP SCHEMATIC DIAGRAM



SCHEMATIC DIAGRAM (DSP)
LH-T6740
SD0300587(sht04)

• AMP SCHEMATIC DIAGRAM

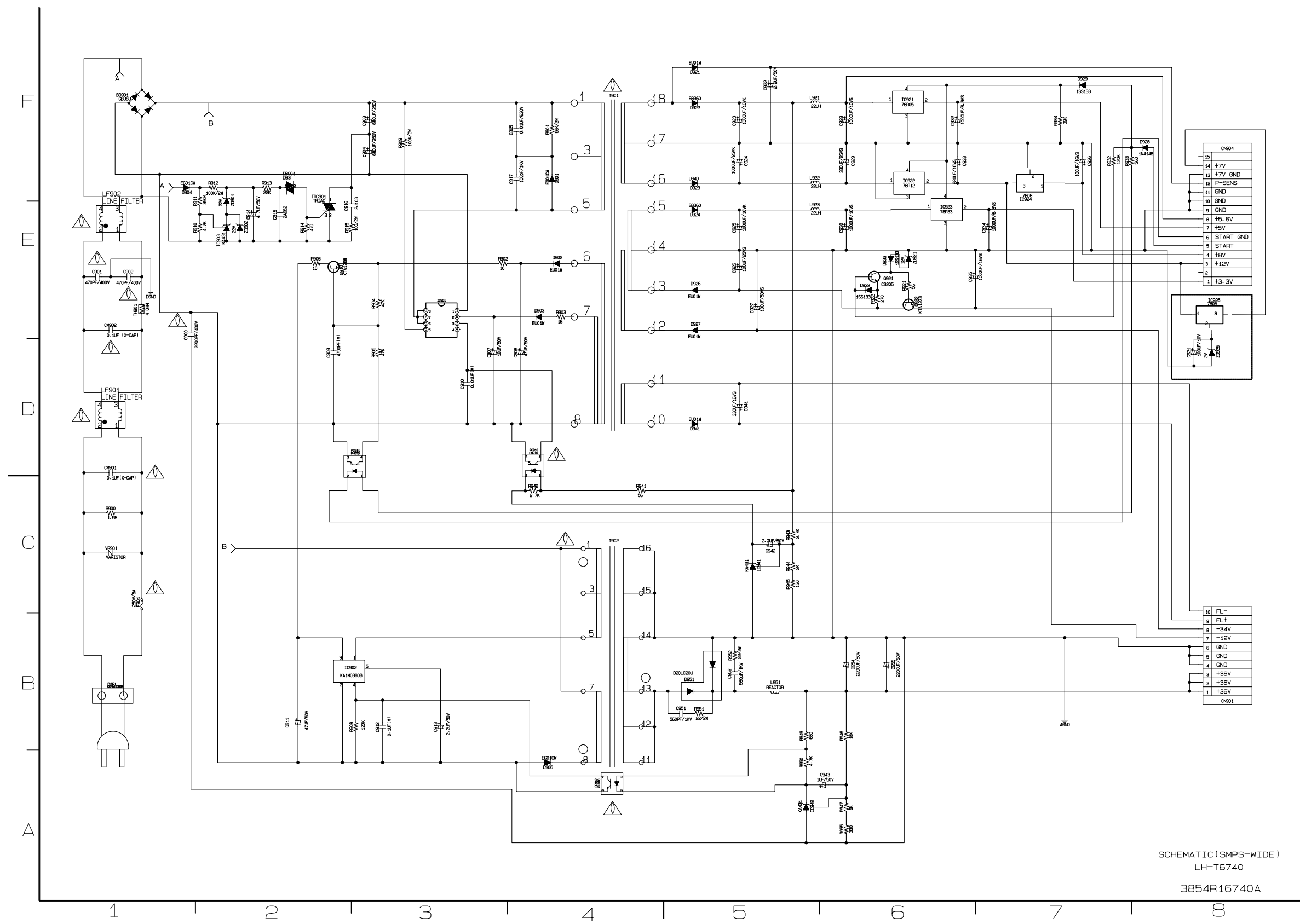


SCHEMATIC DIAGRAM (DSP)

LH-T6740

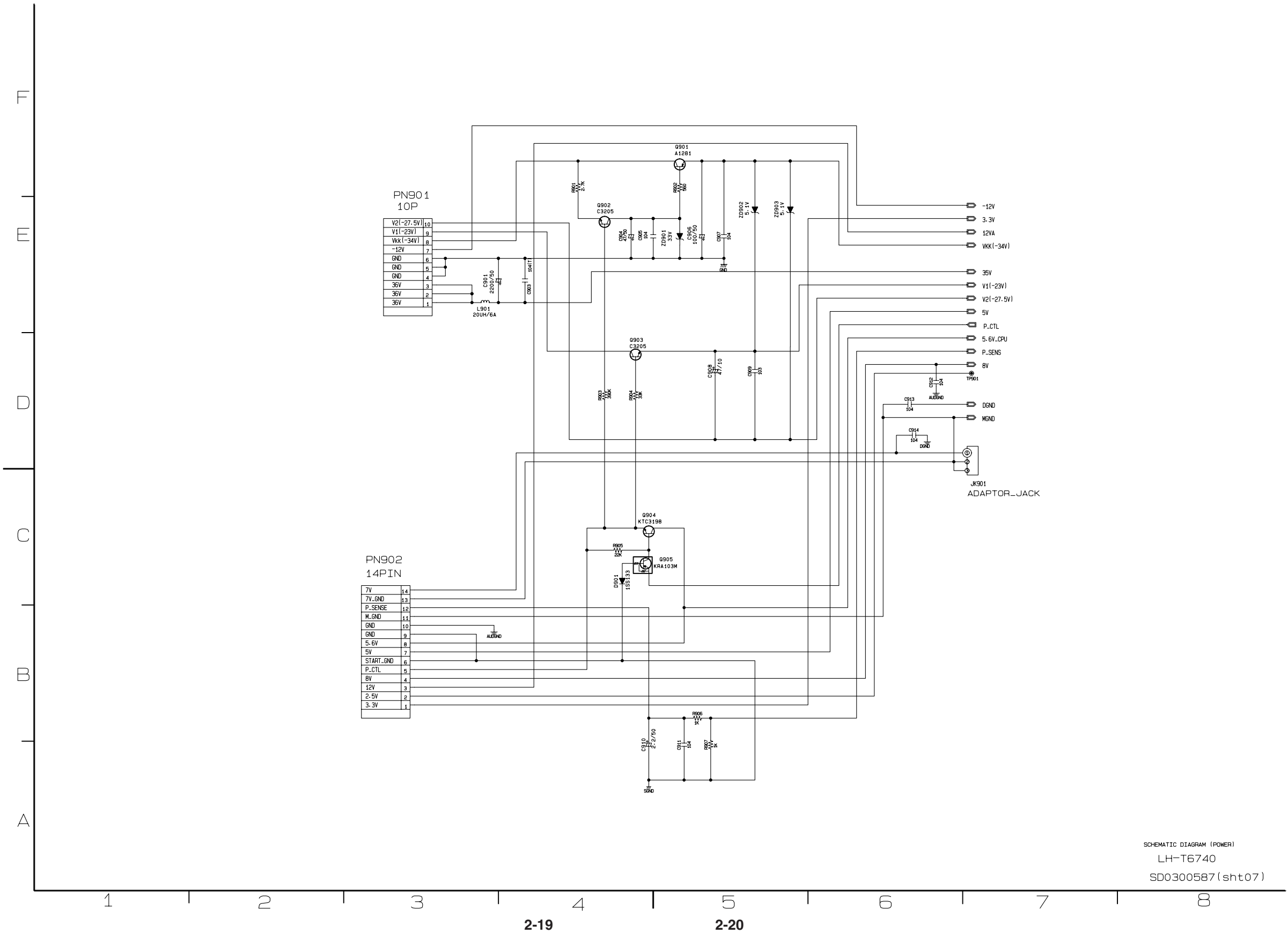
SD0300587(sht06)

• SMPS-WIDE SCHEMATIC DIAGRAM



SCHEMATIC (SMPS-WIDE)
LH-T6740
3854R16740A

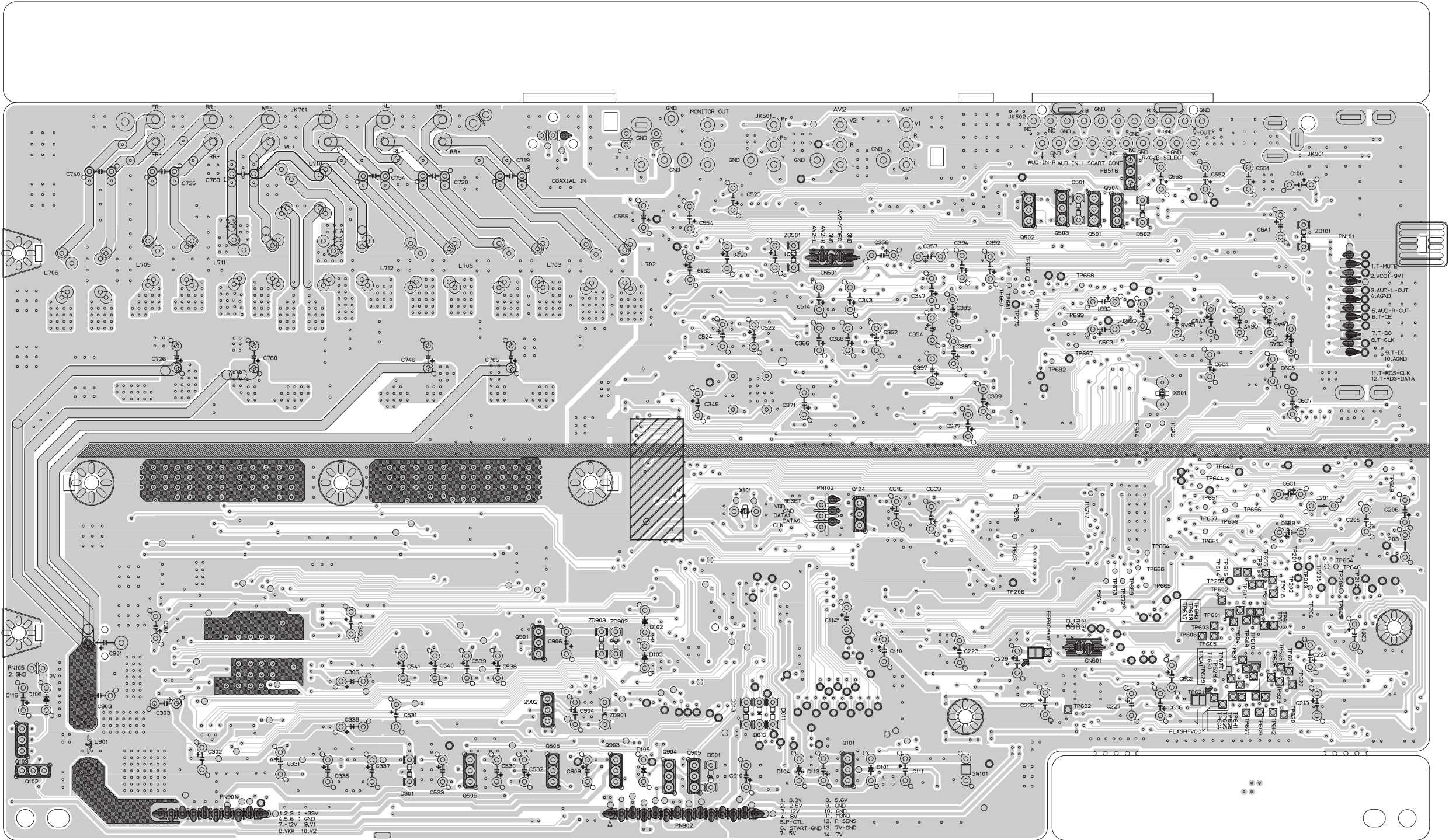
• POWER SCHEMATIC DIAGRAM



• **MAIN P.C. BOARD (COMPONENT SIDE)**

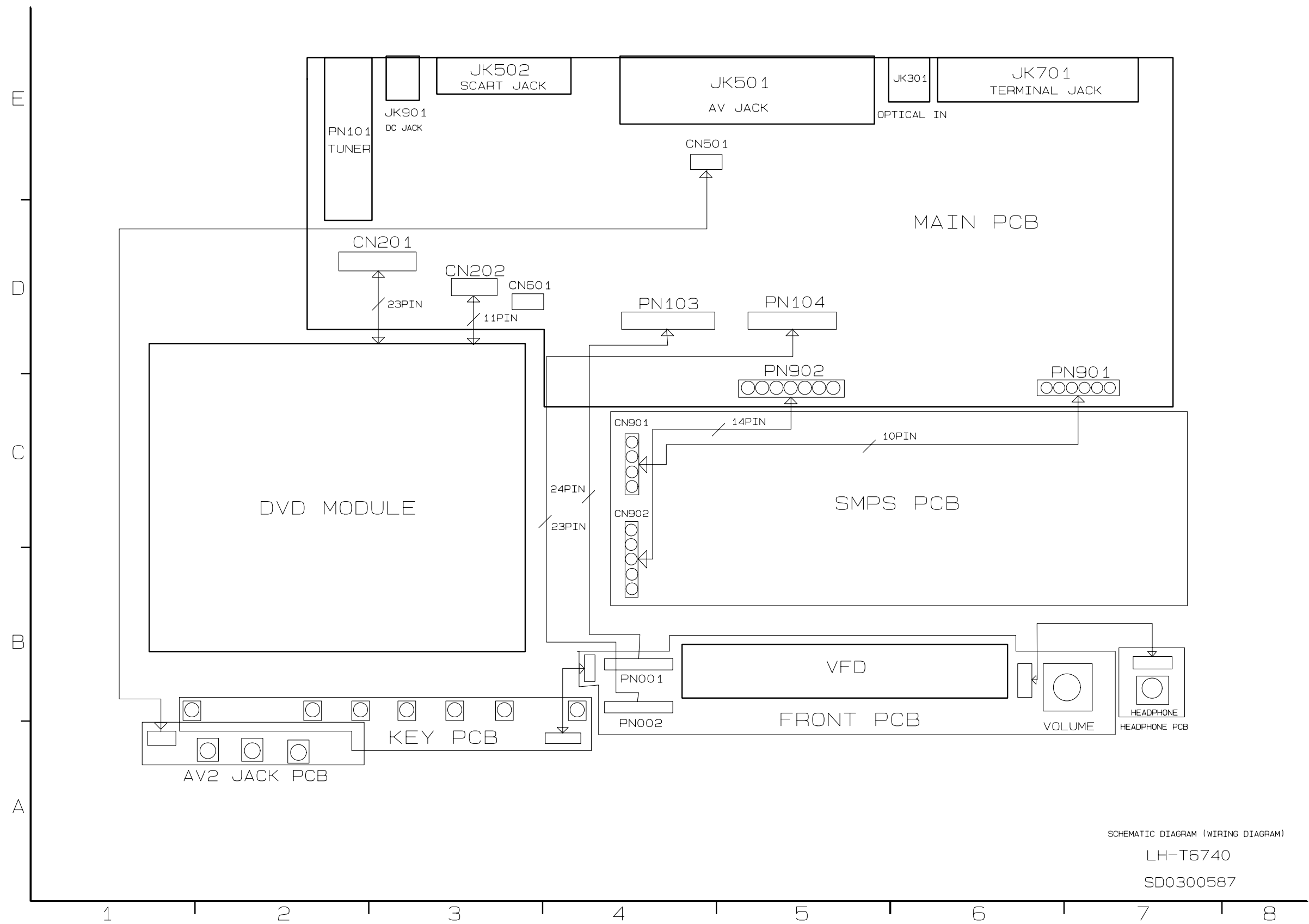


• MAIN P.C. BOARD (SOLDER SIDE)



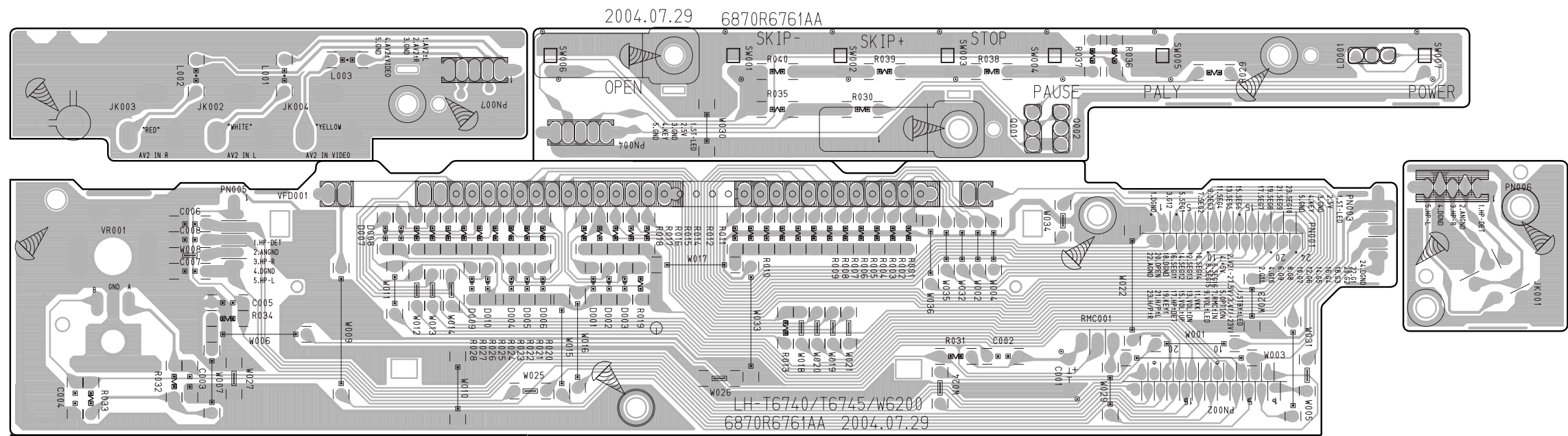
BOT BOTTOM+ SILK

❑ WIRING DIAGRAMS

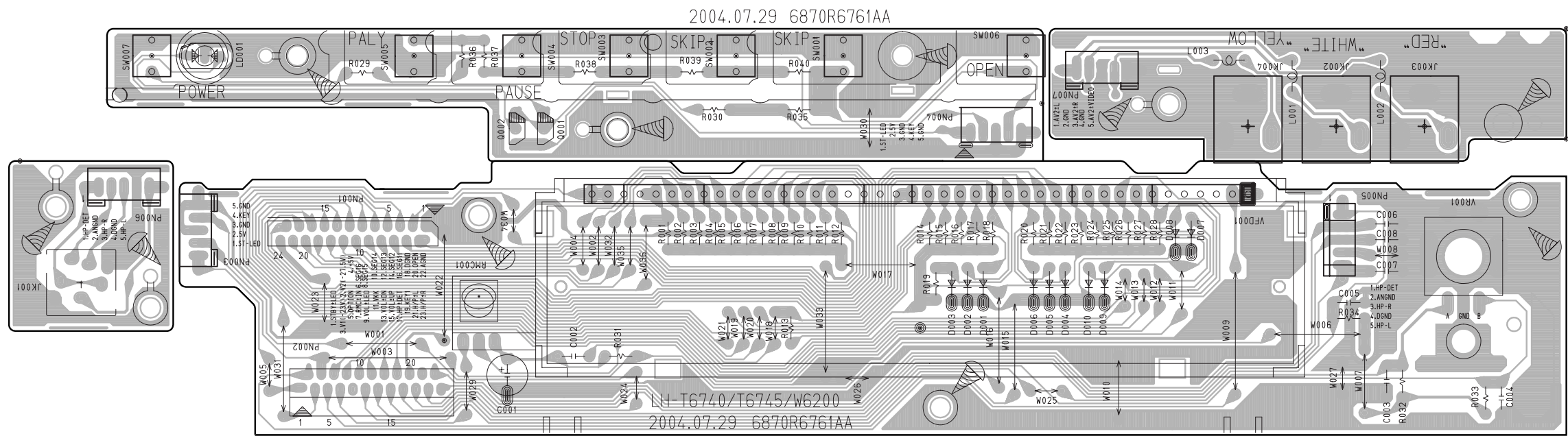


SCHEMATIC DIAGRAM (WIRING DIAGRAM)
LH-T6740
SD0300587

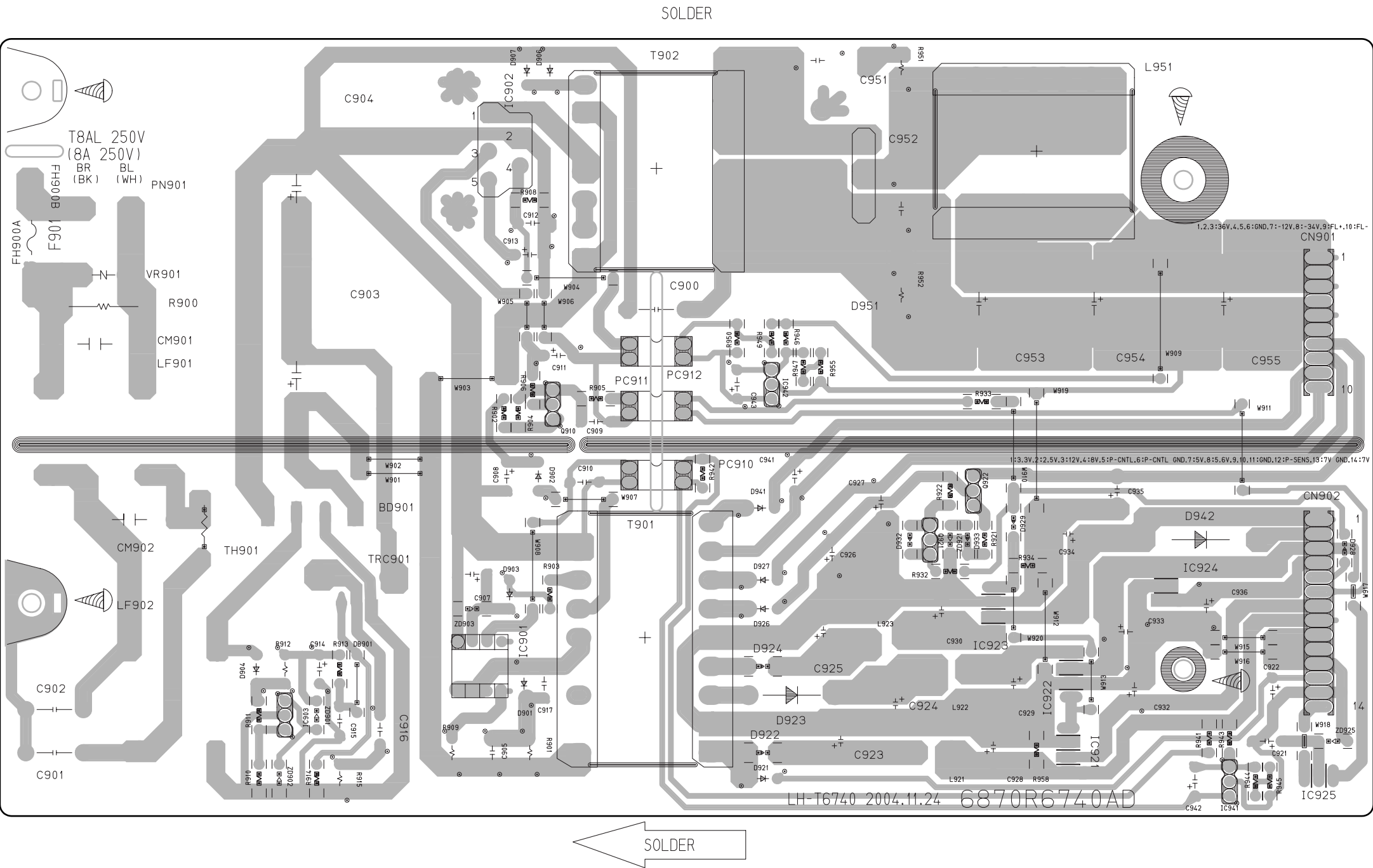
• FRONT P.C.BOARD (SOLDER SIDE)



• FRONT P.C.BOARD (COMPONENT SIDE)



• POWER P.C.BOARD



MEMO

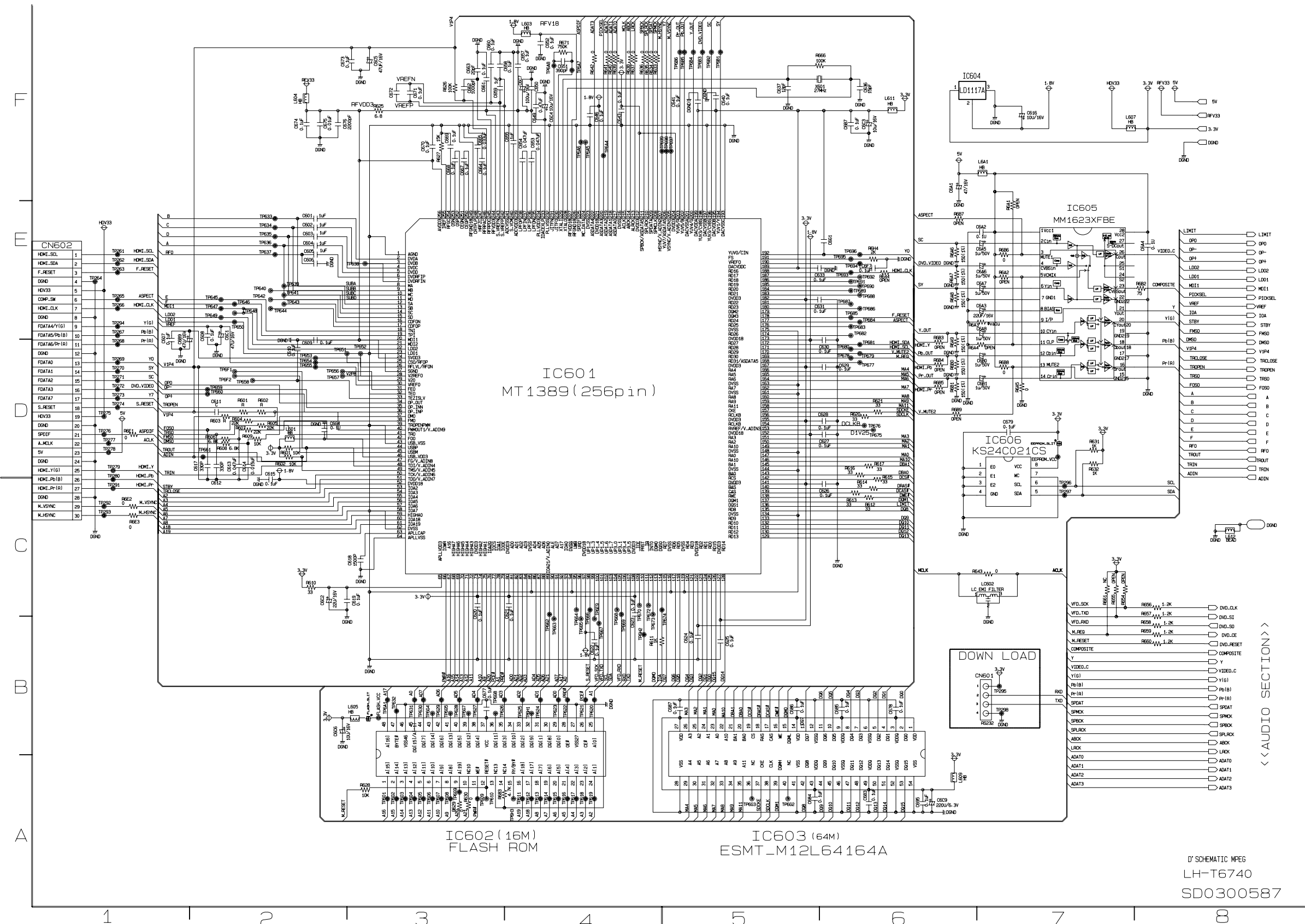
Handwriting practice lines on page 2-31. The page contains 25 horizontal dotted lines for writing.

MEMO

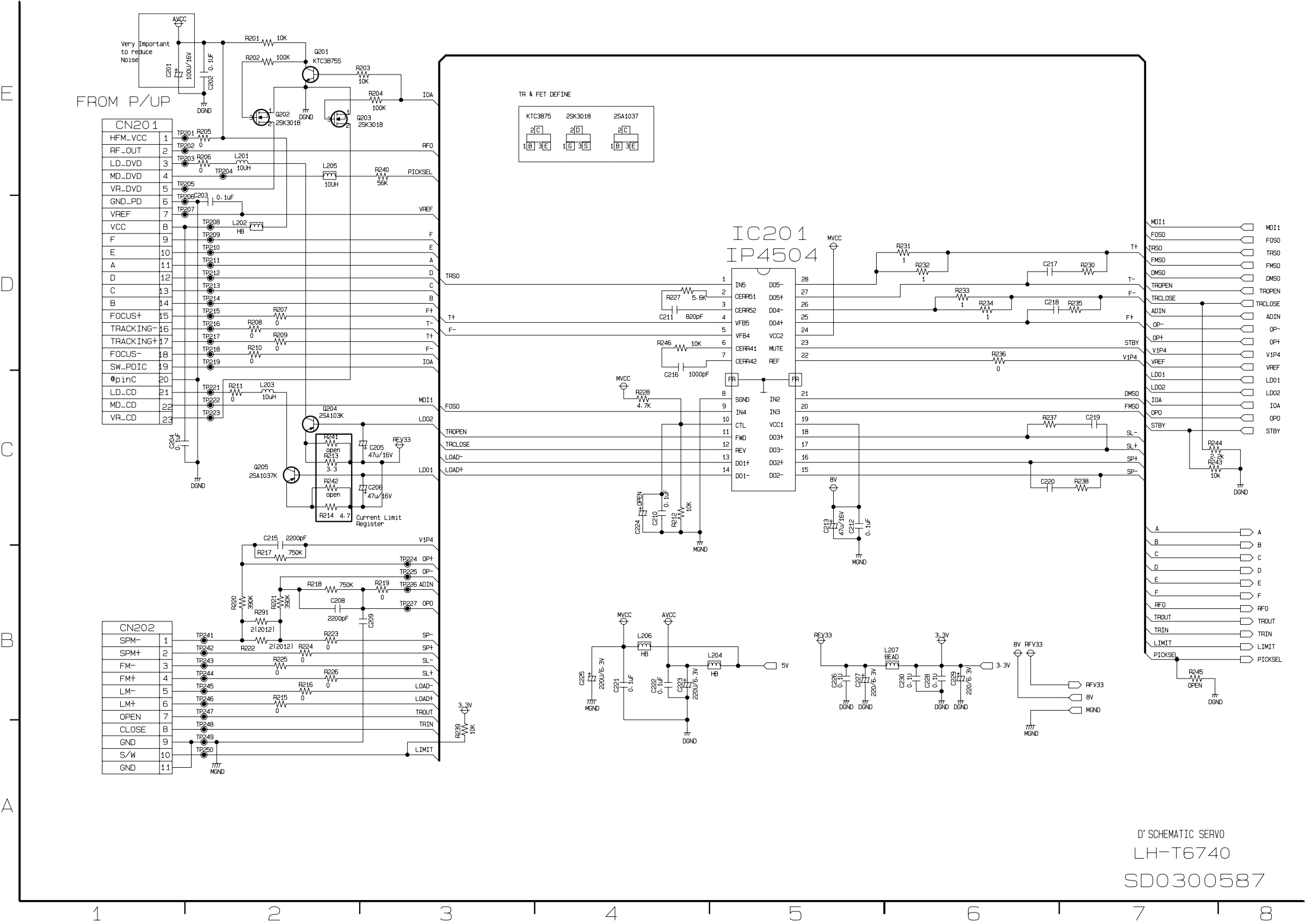
Handwriting practice lines on page 2-32. The page contains 25 horizontal dotted lines for writing.

❑ DVD PART SCHEMATIC DIAGRAMS

• MPEG SCHEMATIC DIAGRAM



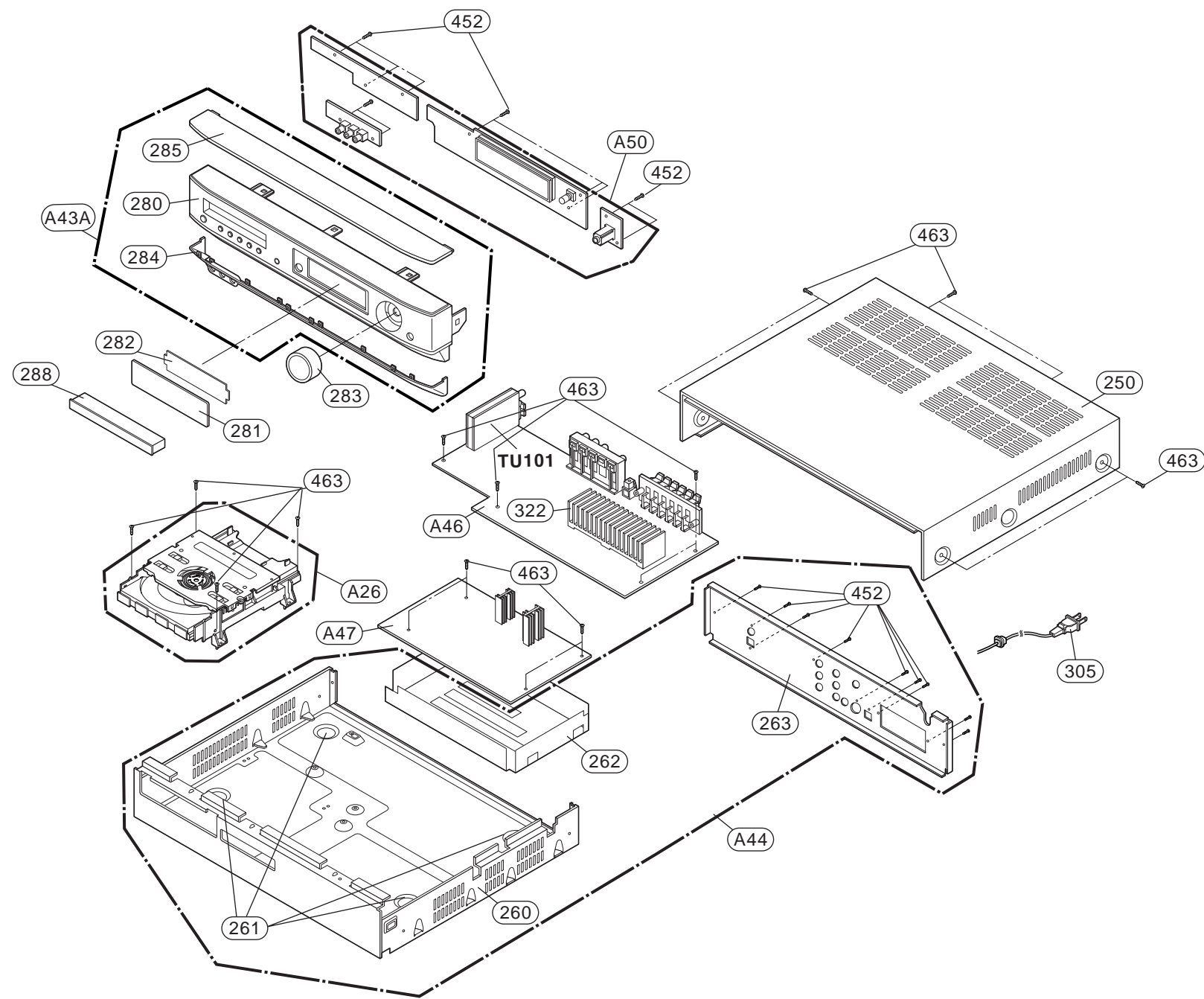
• SERVO SCHEMATIC DIAGRAM



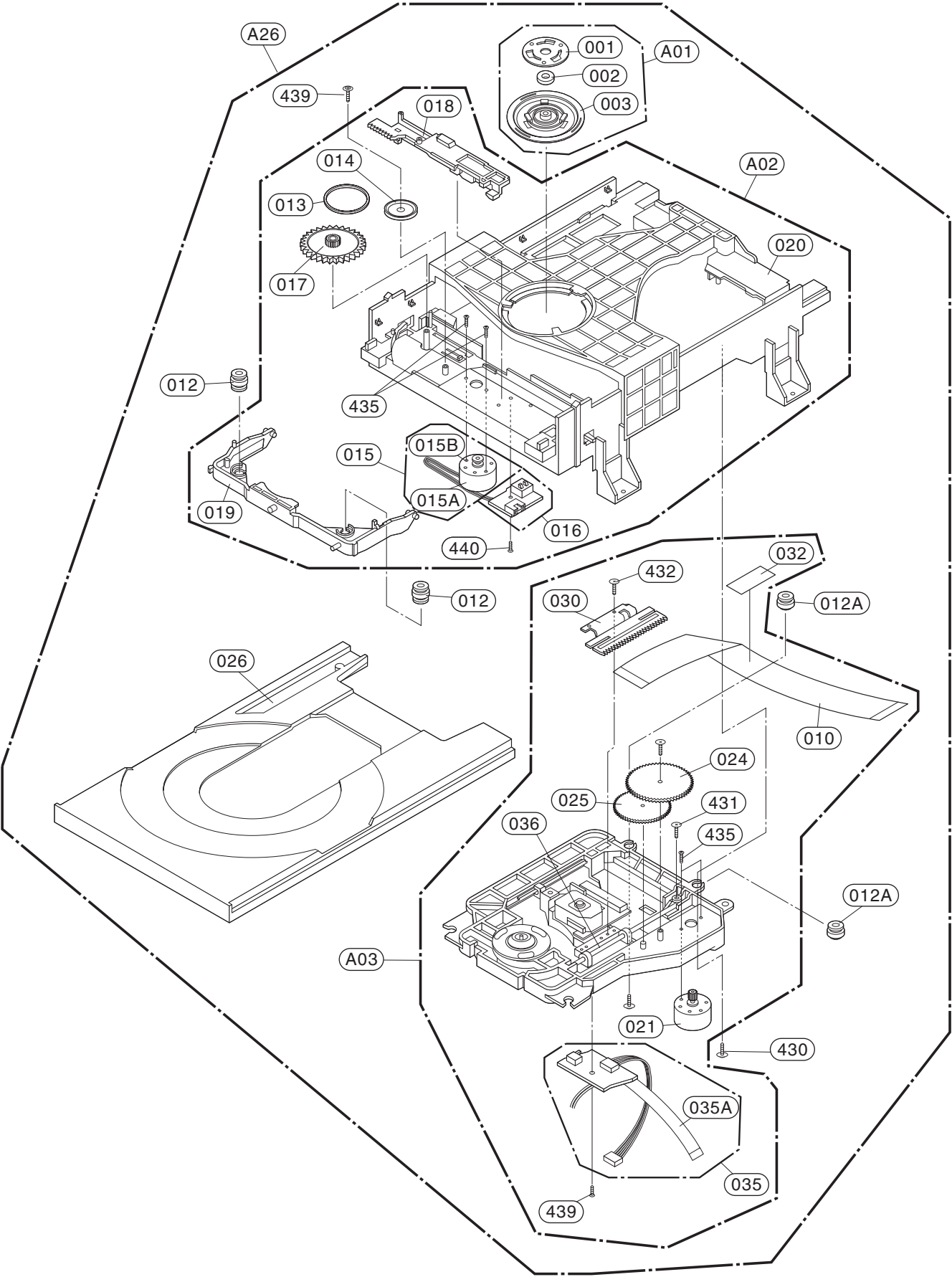
SECTION 4. EXPLODED VIEWS

CABINET AND MAIN FRAME SECTION

NOTE) Refer to “SECTION 6 REPLACEMENT PARTS LIST” in order to look for the part number of each part.

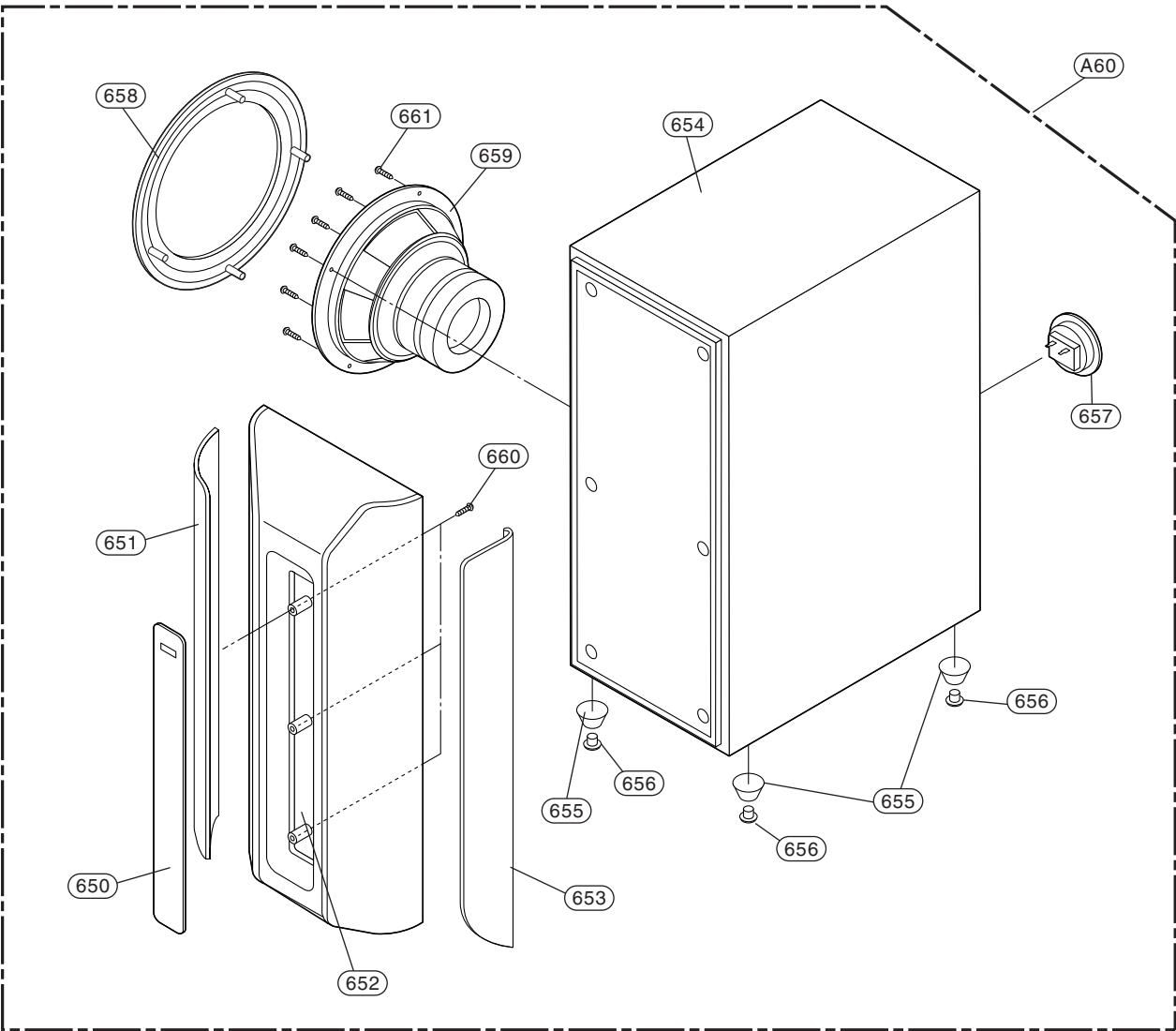


• DECK MECHANISM EXPLODED VIEW

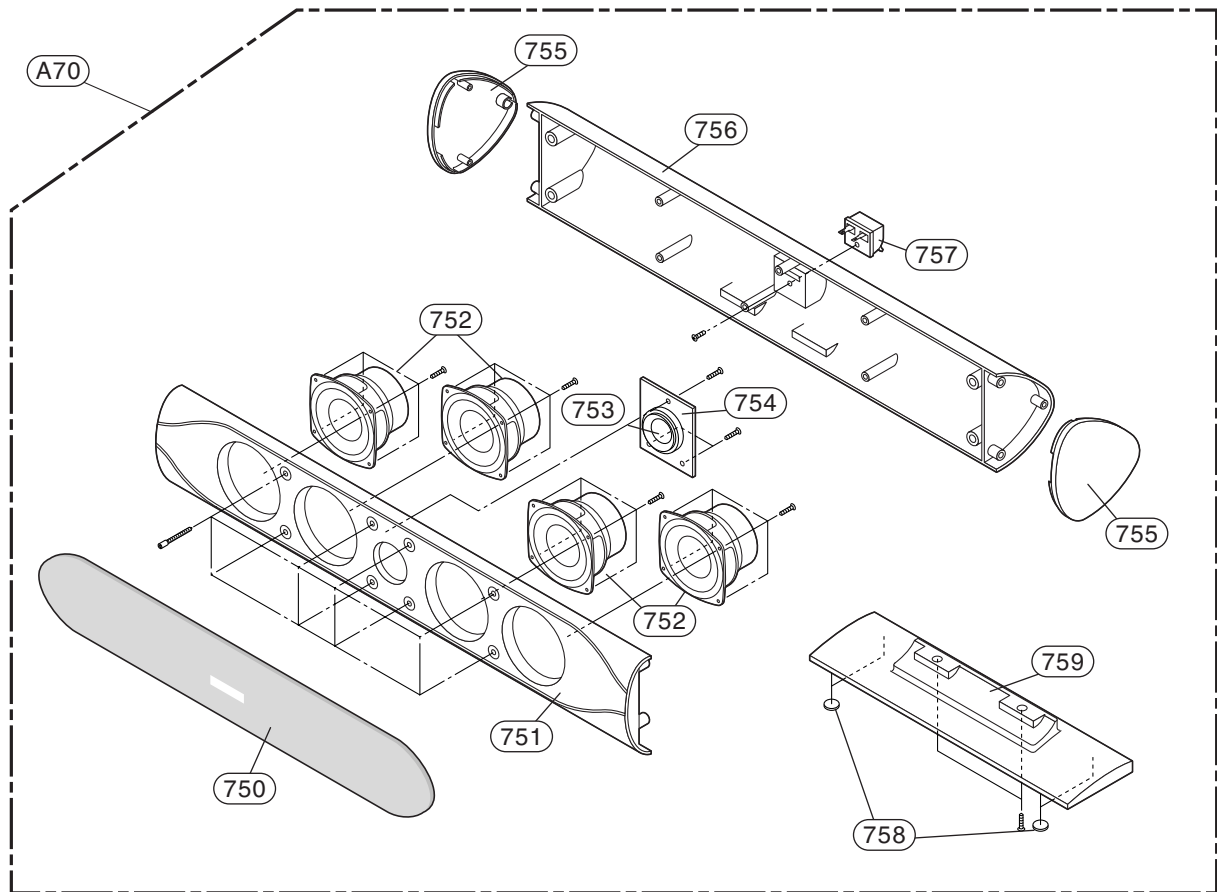


SECTION 5. SPEAKER PART

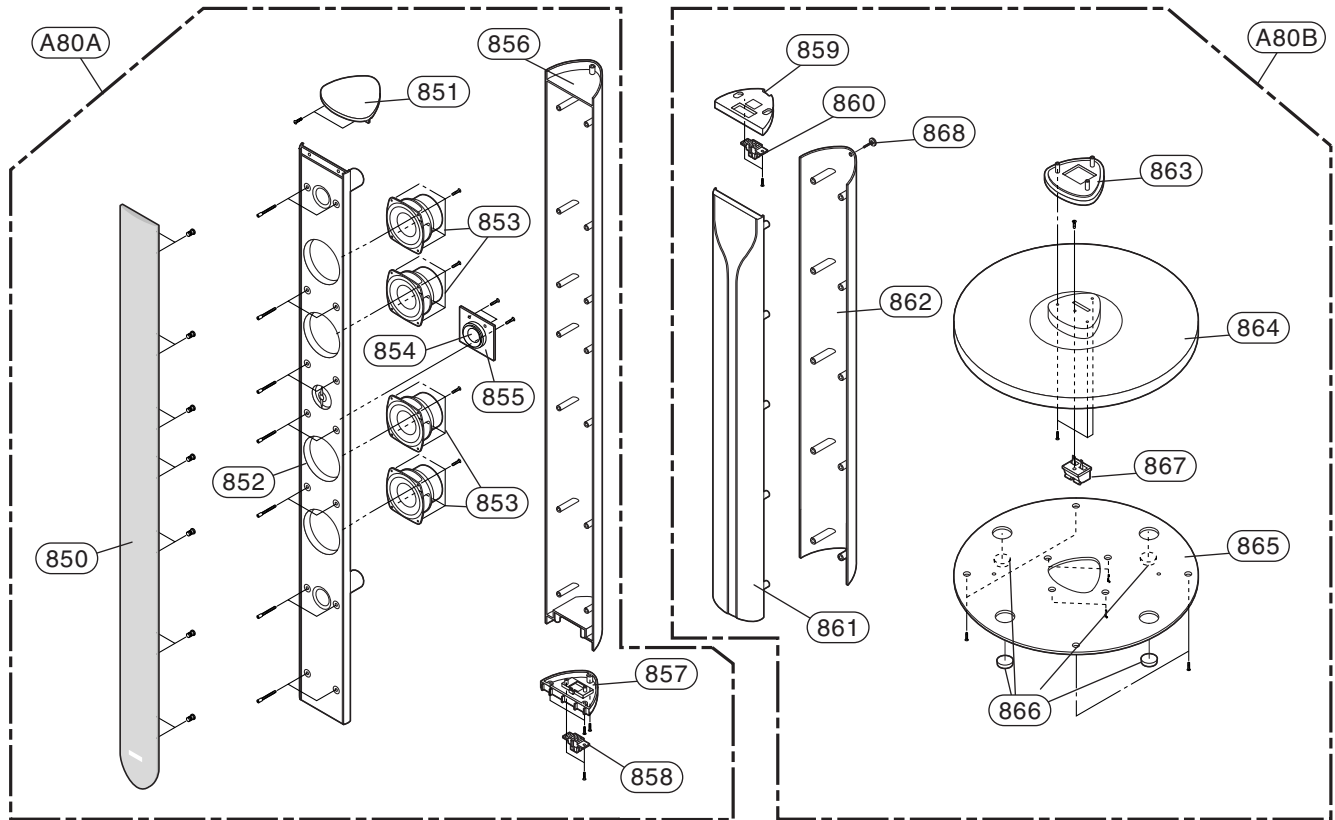
❑ MODEL: LHS-T6749W



❑ **MODEL: LHS-T6749C**



MODEL: LHS-T6749T



MEMO

[illegible]